

SERVICE MANUAL

**MODEL 1540/1541
DISK DRIVE**

Preliminary

APRIL 1986

PN-314002-01



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CONTENTS

Title	Page
SPECIFICATIONS	1
BLOCK DIAGRAM	2
CARE AND MAINTENANCE	3
OVERVIEW	4
FLASH CODE	4
<u>CIRCUIT THEORY</u>	
POWER SUPPLY	5
RESET CIRCUIT	6
CLOCK CIRCUITS	7
MICROPROCESSOR CONTROL OF RAM & ROM	8
SERIAL INTERFACE	9
MICROPROCESSOR R/W AND MOTOR CONTROL LOGIC	10
READ/WRITE CONTROL LOGIC	11
READ AMPLIFIER	12
WRITE AMPLIFIER	13
POWER UP/DOWN WRITE PROTECTION	14
STEPPER MOTOR CONTROL CIRCUITS	15
SPINDLE MOTOR CONTROL CIRCUITS	16
TROUBLESHOOTING GUIDE	17
RESISTANCE CHECKS	19
CASEWORK/ACCESSORY PARTS LIST	20
MODEL IDENTIFICATION	21
DEVICE NUMBER CHANGE	21
<u>PCB ASSEMBLY 1540001</u>	
BOARD LAYOUT	22
PARTS LIST	23
PIN CONFIGURATIONS	25
SCHEMATIC	25
<u>PCB ASSEMBLY 1540048</u>	
BOARD LAYOUT	26
PARTS LIST	27
UPGRADE NOTES	29
SCHEMATIC	29

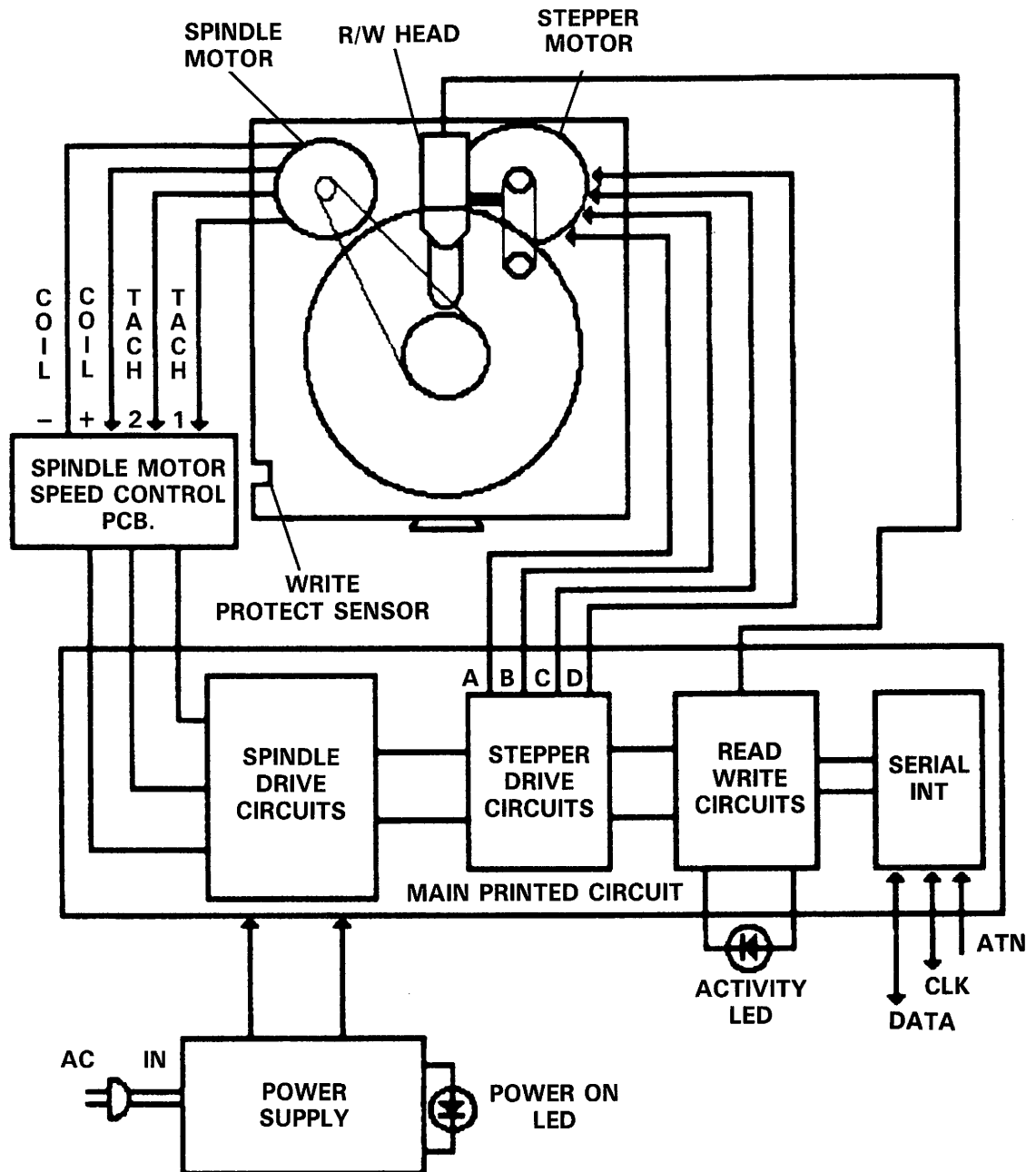
CONTENTS (Continued)

Title	Page
<u>PCB ASSEMBLY 250442, 250446</u>	
BOARD LAYOUT	30
PARTS LIST	31
IC PINOUTS AND INTERNAL DIAGRAMS	33
SCHEMATIC	33
<u>POWER SUPPLY ASSEMBLY 1540002</u>	
PARTS LIST	34
TRANSFORMER	34
ASSEMBLY DRAWING	34
<u>ALPS DRIVE ASSEMBLY</u>	
PARTS LIST	35
WIRING DIAGRAM AND LAYOUT	35
MOTOR CONTROL PCB SCHEMATIC	36
<u>NEWTRONICS DRIVE ASSEMBLY</u>	
PARTS LIST	37
WIRING DIAGRAM AND LAYOUT	37
MOTOR CONTROL PCB SCHEMATIC	38

C1541 DISK DRIVE PRODUCT SPECIFICATION

GENERAL DESCRIPTION	The C1541 Disk Drive is an external 5-1/4 inch floppy diskette recorder, offering high-speed and capacity for programs and data. It is an intelligent device, containing its own microprocessor, RAM, ROM and operating systems software for faster speed of throughput and memory efficiency in the computer.
MAXIMUM STORAGE	170K of data (formatted) — 35 tracks
MEDIA	5-1/4 Inch floppy disk. Single sided, single density, soft sector (double density can be used, but not needed).
INPUT/OUTPUT	Commodore serial interface Second serial port for chaining a second drive or printer
CONTROLLER	MOS 6502 microprocessor — 1 MHz clock
MEMORY	2K RAM, 16K ROM
DATA TRANSFER RATE	400 Bytes/sec
FILE TYPES	Program, sequential, relative, random-access and user
NUMBER OF FILES	Up to 144 different files per diskette
COMPUTERS	C64, VIC 20, SX64, Educator 64, Plus/4, C16
MEDIA COMPATIBILITY	2031, 4040, C1551, C1571
POWER REQUIREMENTS	120 Volts AC, 60Hz — integral power supply with external 1 Amp fuse
POWER CONSUMPTION	30 Watts maximum

BLOCK DIAGRAM



CARE AND MAINTENANCE

- **DO NOT** use **MAGNETIZED** tools when repairing or adjusting a disk drive.
- **DO NOT** place a disk drive near any device which generates "noise" e.g., — motors, radios, televisions.
- **DO NOT** stack drives upon each other or in any way inhibit air flow around the unit. **HEAT BUILD-UP** can cause disk failures.
- Periodically **CLEAN** the read/write head with **90% isopropyl alcohol** and a **cotton swab**. **CHECK** load pad for excess wear. Clean or replace as necessary.
- Take the following precautions when handling a diskette:
 - ALWAYS** store a diskette in its jacket.
 - Use **ONLY** felt-tip pens when writing on the label of a diskette.
 - Do not bend or physically damage a diskette.
 - Do not place a diskette in the area of a magnetic field.
 - Do not attempt to clean a diskette.
 - Do not touch the exposed area of a diskette.
- **DIAGNOSTIC** and **ADJUSTMENT** procedures are outlined in detail on the **diagnostic disk** (Commodore Part #31405101). A manual has been added to the diagnostic package. It contains descriptions of testing procedures and adjustment methods.

OVERVIEW

The drive is itself an independent memory device. The drive is composed of a media clamp rotating mechanism, a head positioning mechanism and an eject mechanism. All positioning operations, excluding insertion and removal of the diskette, are controlled by the internal guide mechanism. Closing the front door causes the media clamp mechanism to operate. Two operations are performed in the following order:

- a) The diskette is centered.
- b) The diskette is clamped and retained between the spindle and the hub.

The spindle and hub rotate at 300 r.p.m. through a closed-loop control circuit employing a D.C. motor/tachometer. It is important that the relationship between the head and the media is maintained correctly during operation. For this purpose, a pressure pad is used to hold and press down the media (about 12g) from the opposite side of the head. This head assembly is coupled by a metal band to a four phase stepping motor which performs the track positioning. One step of the stepping motor corresponds to a 1/2 track movement. The control circuit on the logic board selects the direction and number of steps to the desired track.

The Read/Write head uses a glass-bonded, ferrite/ceramic head. Track-to-track erasing is accomplished by the straddle erase method. The surface of the Read/Write head is mirror-ground to minimize wear of the head and media. Also, the head is designed in such a way that the maximum signal can be obtained from the media surface.

The spindle drive motor operates on 12 VDC and turns the spindle, through a belt drive, at 300 revolutions per minute. The speed of the drive motor is controlled by a feedback signal from a tachometer, which is housed in the drive motor assembly. The feedback signal controls a servo amp that supplies the 12 VDC drive current.

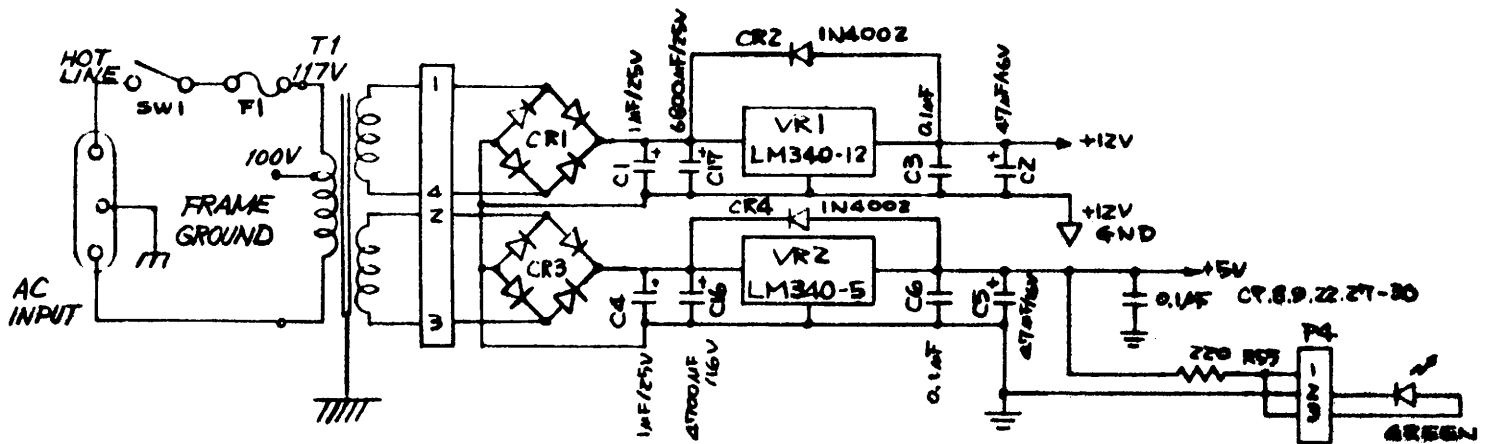
FLASH CODE

The 1541, upon power-up, goes through its own internal diagnostic. If an electronic problem is detected, it is indicated by a FLASH CODE. The LED's will blink a set number of times, pause, and then flash again until the problem is corrected.

Number of Flashes	Possible Failure
2	Zero Page
3,4	DOS ROM's
5,6,7,8	RAM

Circuitry associated with these components can also cause the failure code. Therefore, it should be suspected as the next possible defect.

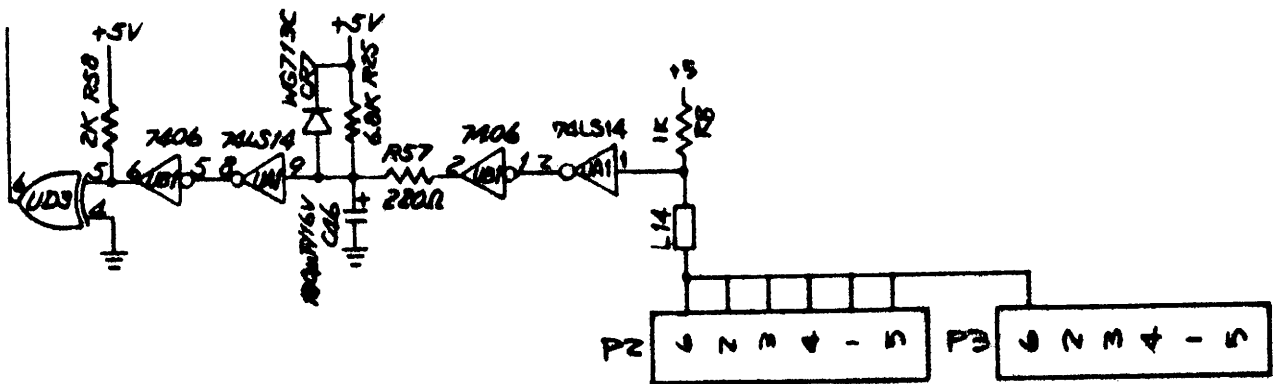
1541 CIRCUIT THEORY



All circuit diagrams have been taken from the short board schematic 1540049 unless otherwise noted. The short boards use a 6116 RAM which replaces the four 2114 I.C.s on the long board. See page 11 for the Read/Write logic differences.

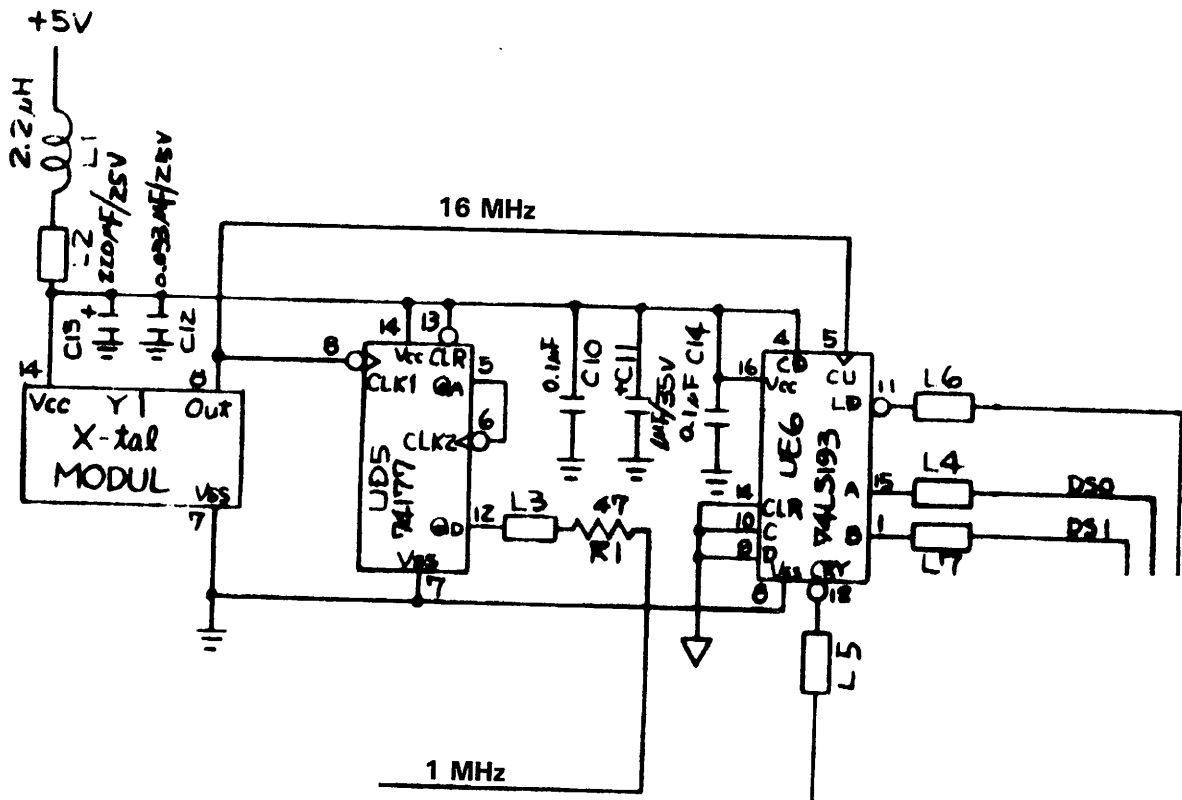
The Power Supply

The input AC voltage is controlled by switch 1 (SW1). Disk circuit protection is provided by fuse 1 (F1). If SW1 is closed, the AC voltage input is applied to the primary winding of transformer one (T1). T1 steps down the AC input voltage into two smaller AC voltages. The top secondary AC output (approx. 16VRMS) is converted to DC by the Full Wave Bridge Rectifier CR1. The DC output of CR1 is regulated at 12VDC by VR1. The bottom secondary AC output of T1 (approx. 9VRMS) is converted to DC by the Full Wave Bridge Rectifier CR3. The DC output of CR3 is regulated at +5VDC by VR2. High frequency filtering is provided by C1 and C3 for the 12VDC supply, and C4, C6 to C9, C22, C27 to C30 for the 5VDC supply. Low frequency filtering is provided by C17 and C2 for the 12VDC supply, and C5 and C16 for the 5VDC supply.



The Reset Circuit

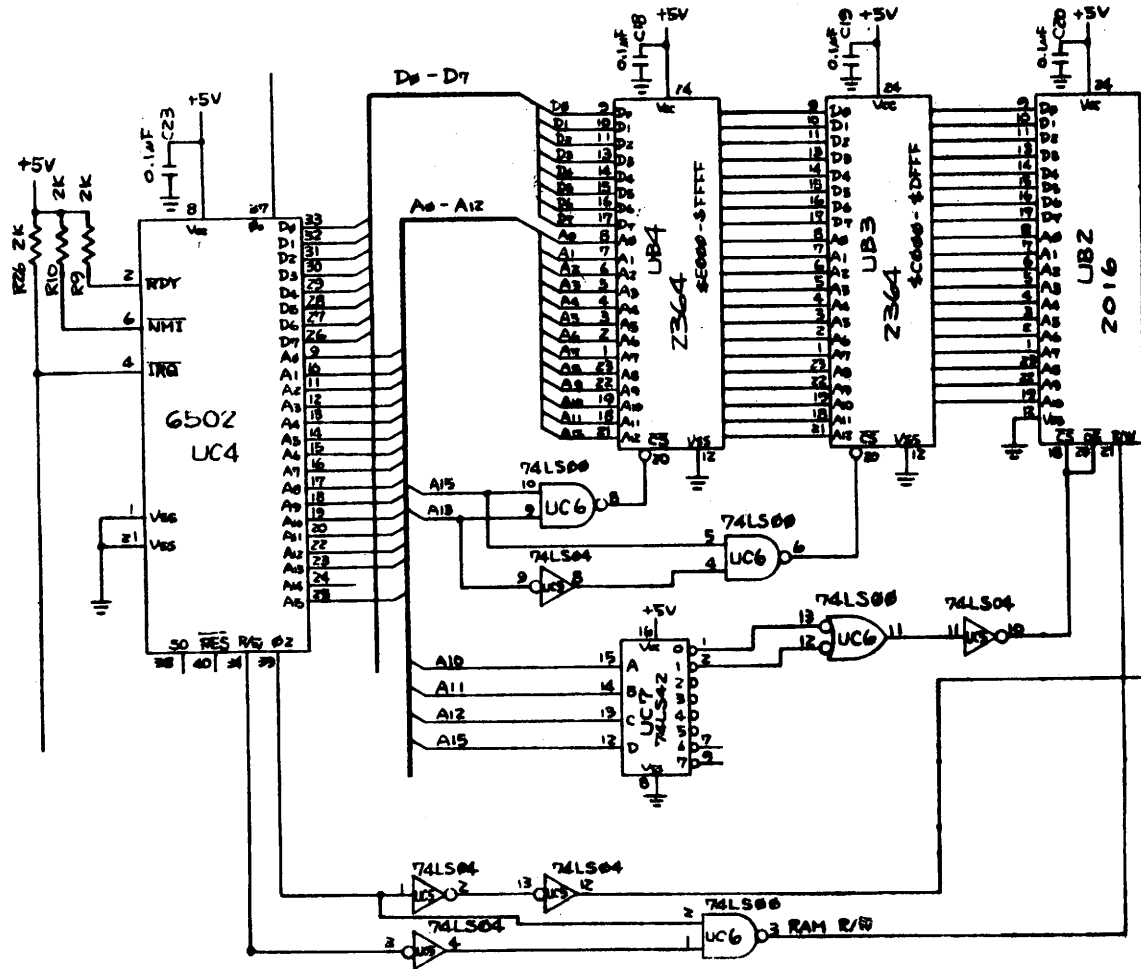
The output of the exclusive 'or' gate UD3 pin 6 will be "low" until C46 has charged through R25. Once the voltage across C46 reaches 2 volts, the output of UD3 pin 6 will go "high". This occurs when the disk is powered on, or a reset pulse is generated by a device connected to the serial bus. The reset pulse on the serial bus interface is input on, pin 6 of P2 or P3. This "low" to "high" going pulse on pin 6 of UD3 is input to the microprocessors reset interrupt input. This causes a restart or reset routine to be executed giving control of the disk drive operation to the Disk Operating System (DOS).



The Clock Circuits

Crystal Y1 outputs a 16 MHz clock signal. This is input to UD5 on pin 8. UD5 is configured as a $\div 16$ frequency divider. The output of UD5 pin 12 is a 1 MHz clock signal used as the system clock (Phase 0) for the microprocessor. UE6 is a programmable counter ($\div 16$, $\div 15$, $\div 14$, $\div 13$) that outputs a varying frequency clock used to compensate for the difference in recording area/sector for sectors on inner tracks (Trks 1,2,3) as compared to sectors on out most tracks (Trks 33,34,35). The area/sector for inner tracks is less than the area/sector for out most tracks, so the recording clock frequency is increased when writing on inner tracks to keep the flux density constant. This clock output is on pin 12 of UE6.

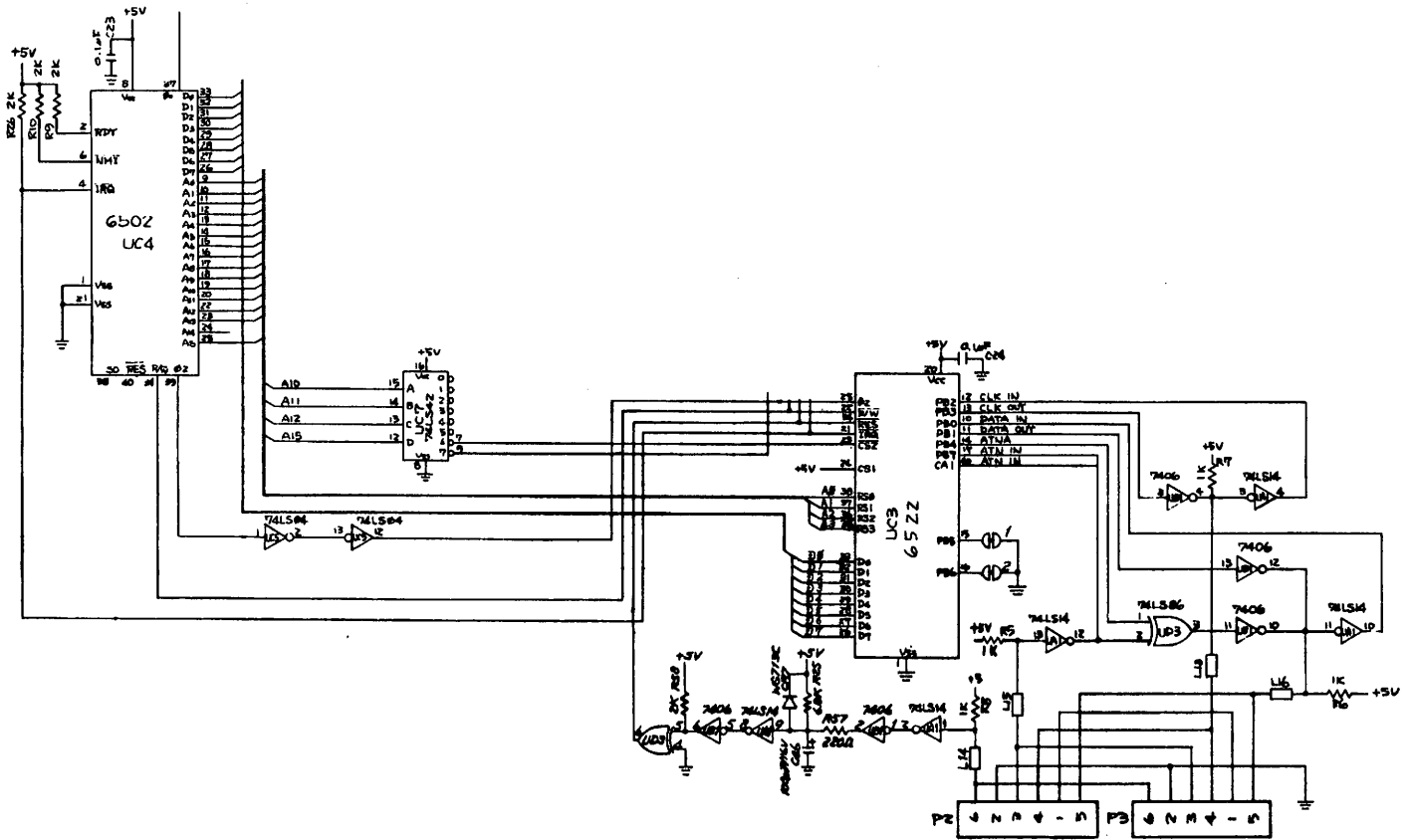
Tracks	Clock Frequency	Divide By
1-17	1.2307 MHz	13
18-24	1.1428 MHz	14
25-30	1.0666 MHz	15
31-35	1 MHz	16



Microprocessor Control of RAM and ROM

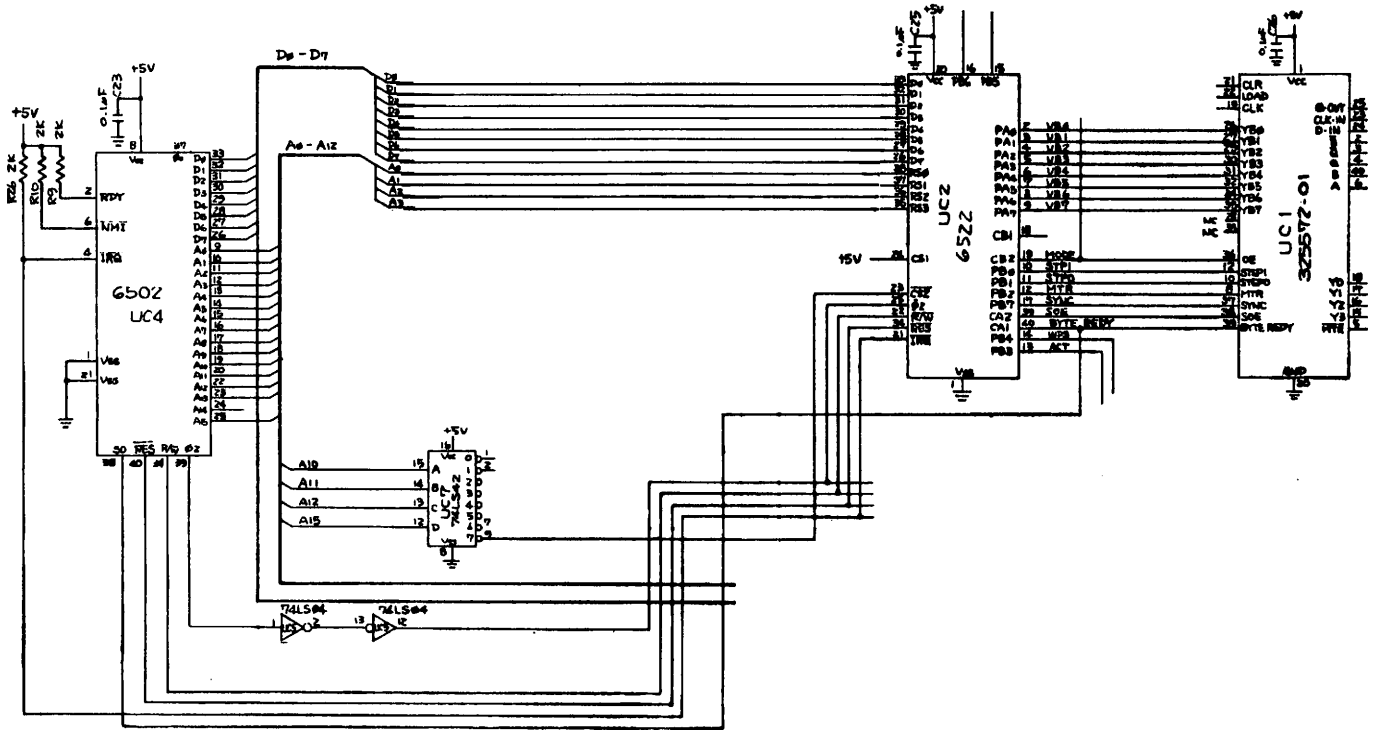
UB3 and UB4 are 8192 x 8 bit ROMs that store the Disk Operating System (DOS). UB3 resides at memory locations \$C000-\$DFFF. UB4 resides at memory locations \$E000-\$FFFF. UC5 and UC6 decode the addresses output from the microprocessor when selecting these ROMs.

UB2 is a 2048 x 8 bit RAM. UB2 resides at memory locations \$0000-\$07FF. This memory is used for processor stack operations, general processor housekeeping, user program storage, and 4 temporary buffer areas. UC5, UC6, and UC7 decode the addresses output from the processor when selecting RAM.



The Serial Interface

UC3 is a 6522 Versatile Interface Adapter (VIA). Two parallel ports, handshake control, programmable timers, and interrupt control are standard features of the VIA. Port B signals (PB0-PB7) control the serial interface driver IC's (UB1 and UA1). CLK and DATA signals are bidirectional signals connected to pins 4 and 5 of P2 and P3. ATN (Attention) is an input on pin 3 of P2 and P3 that is sensed at PB7 and CA1 of UC3 after being inverted by UA1. ATNA (Attention Acknowledge) is an output from PB4 of UC3 which is sensed on the data line pin 5 of P2 and P3 after being exclusively "ored" by UD3 and inverted by UB1. UC3 is selected by UC7 pin 7 going "low" when the proper address is output from the processor. UC3 resides at memory locations \$1C00-\$1C0F.



Microprocessor R/W and Motor Control Logic

UC2 is a VIA also. During a write operation the microprocessor passes the data to be recorded to Port A of UC2. The data is then loaded into the PLA parallel port (YB0-YB7). The PLA contains a shift register which converts the parallel data into serial data. The PLA generates signals on pins 2, 3, 4, and 40 which control the write amplifiers during the write operation. During a read operation serial data is received from the read amplifier circuits on D-IN input on pin 24 of the PLA. The PLA shift register converts serial data into parallel data that is latched at the parallel port (YB0-YB7). The microprocessor reads the parallel PLA output by reading Port A of UC2 when BYTE READY on pin 39 goes "low".

The stepper motor is controlled by two outputs on port B of UC2 (STP0, and STP1). A binary four count is developed from these two lines, driving the four phases of the stepper motor. The PLA converts STP0 and STP1 into four outputs that represent one of the four states in the count (Y0,Y1,Y2,Y3). The Spindle motor is controlled by the output MTR of UC2. The PLA inverts this signal. It is then passed to the motor speed control pcb.

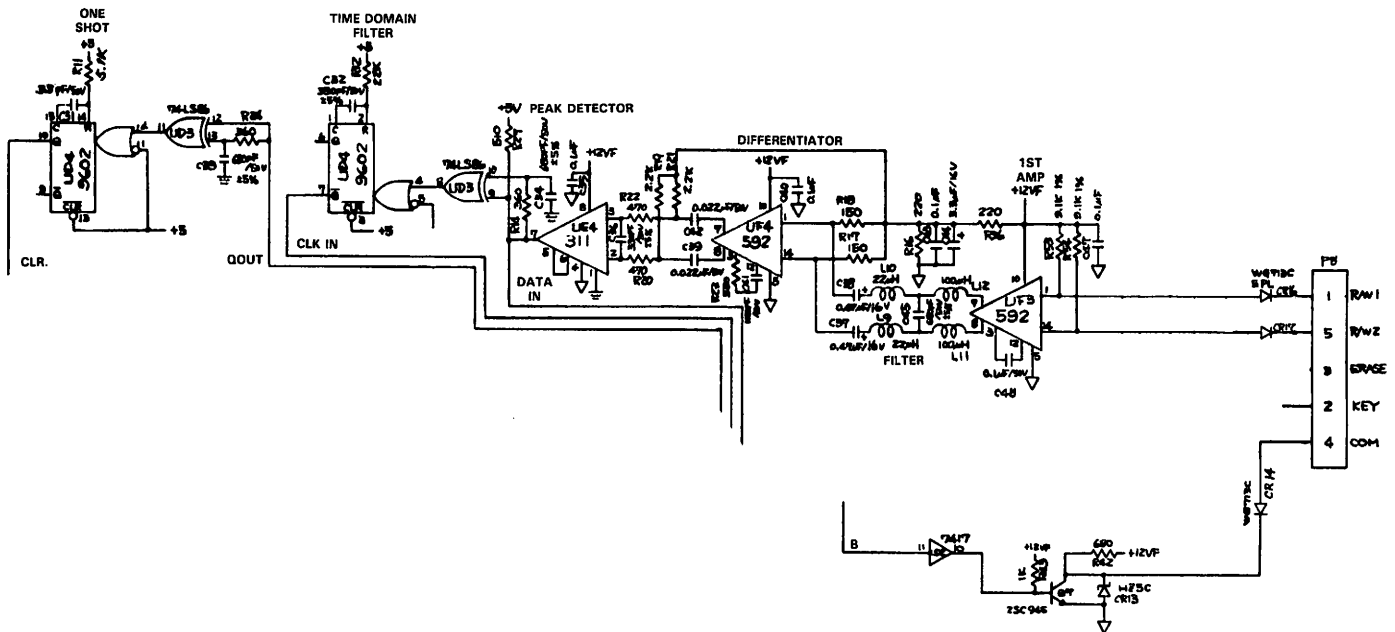
UC2 pin 14 is an input that monitors the state of the write protect sensor, and pin 13 is an output that controls the activity light (RED LED). UC7 decodes the addresses output from the processor when selecting UC2. UC2 resides at memory locations \$1800-\$180F.

The circuit shown here is from the long board schematic 1540008. This logic was integrated in the PLA (Programmable Logic Array) on the short boards.

Read/Write Control Logic

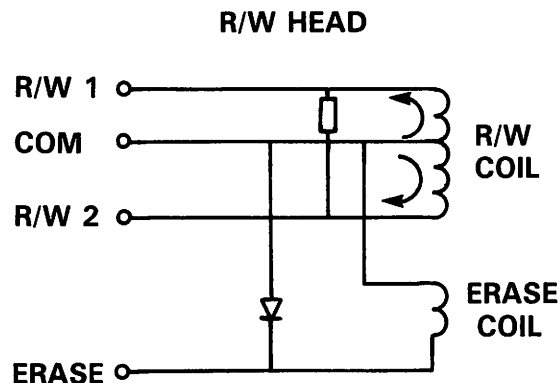
During a write operation, UD3 converts parallel data into serial data. The output on pin 9 is input to 'NAND' gate UF5 pin 4. UF5 outputs the serial data on pin 6 at the clock rate determined by input signal on pin 5. The output clocks the D flip flop UF6. The outputs of UF6, Q and $\overline{Q}$, drive the write amplifiers.

During a read operation, data from the read amplifiers is applied to the CLR input of counter UF4. The outputs, C and D, are shaped by the 'NOR' gate UE5. UE5 outputs the serial data on pin 1, then it is converted to parallel data by UD2. The output of UD2 is latched by UC3. The serial bits are counted by UE3, when 8 bits have been counted, UF3 pin 12 goes "low", UC1 pin 10 goes "high", and UF3 pin 8 goes "low" indicating a byte is ready to be read by the processor. UC2 monitors the parallel output of UD2, when all 8 bits are "1", the output pin 9 goes "low" indicating a sync bit has been read.

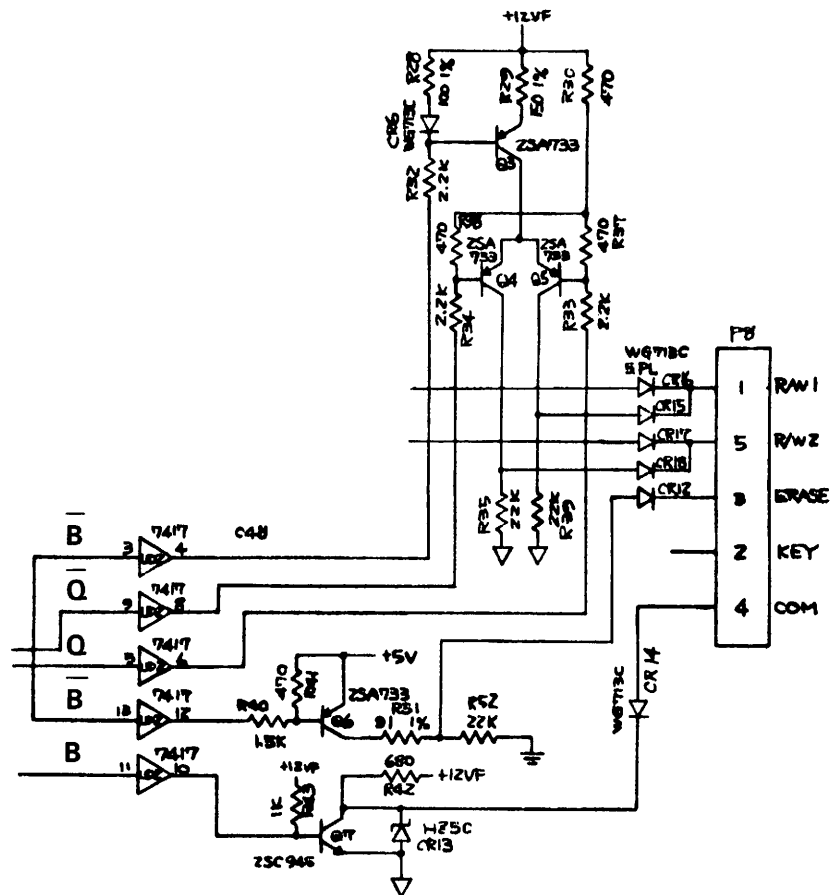


Read Amplifier Circuits

When data is recorded on the disk, a "1" bit is represented on the disk by a change in direction of magnetic flux, caused by a change in direction of current passed through the R/W coil in the R/W head. When a "0" bit is to be recorded, no change in current flow direction occurs, causing the direction of the magnetic flux to remain the same on the disk.



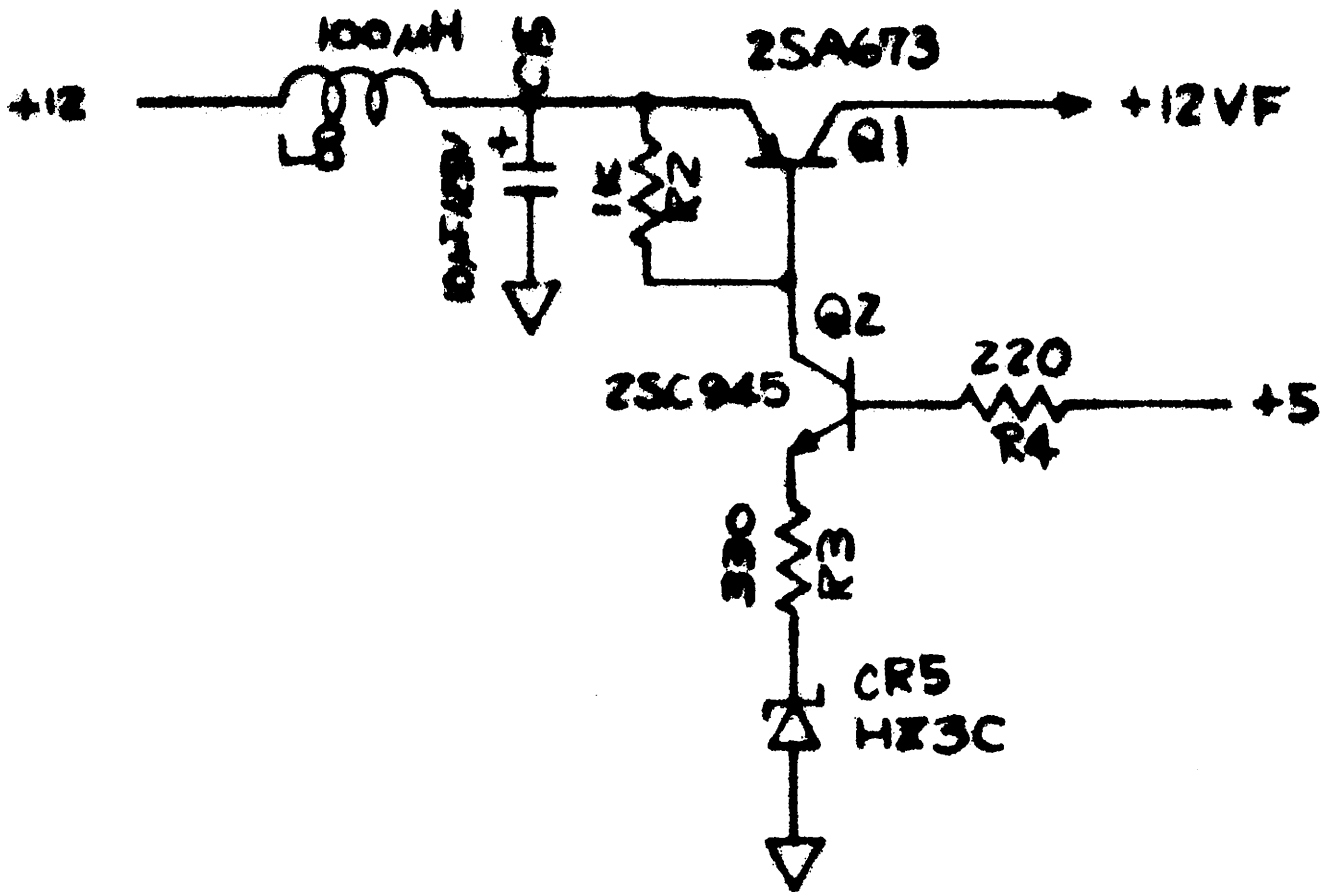
When data is being read from the disk, CEMF is induced into the R/W coil by the magnetic fields on the disk, causing current flow which is detected by the read amplifiers. Current flow through the R/W coil will forward bias either CR16 or CR17, depending on the direction. Q7 and CR14 must be forward biased. The first amplifier UF3, senses this current flow from the R/W coil on one of the inputs and amplifies it. L9, L10, L11, L12 and C45 act as a low pass filter, suppressing noise on the amplified output. UF4 is a differential amplifier which amplifies the difference of the two input signals from the filter section. UE4 is a peak detector. The output of UE4 will pulse "high" when a "1" is read. This signal is the reconstruction of data recorded. The Time Domain Filter, UD4, times out when a "1" bit has been read, so unwanted "1" bits are not added to the actual data. The One Shot UD4 generates the correct data pulse width so the PLA can convert the data to parallel for processor control.



Write Amplifier Circuits

During a write operation, B must be "high". This forward biases Q7 and CR14. If $\overline{B}$ goes "low", Q3 and Q6 become forward biased. If Q goes "low", Q5 and CR15 become forward biased, passing current flow through R/W 1. If $\overline{Q}$ goes "low", Q4 and CR18 become forward biased, passing current flow through R/W 2.

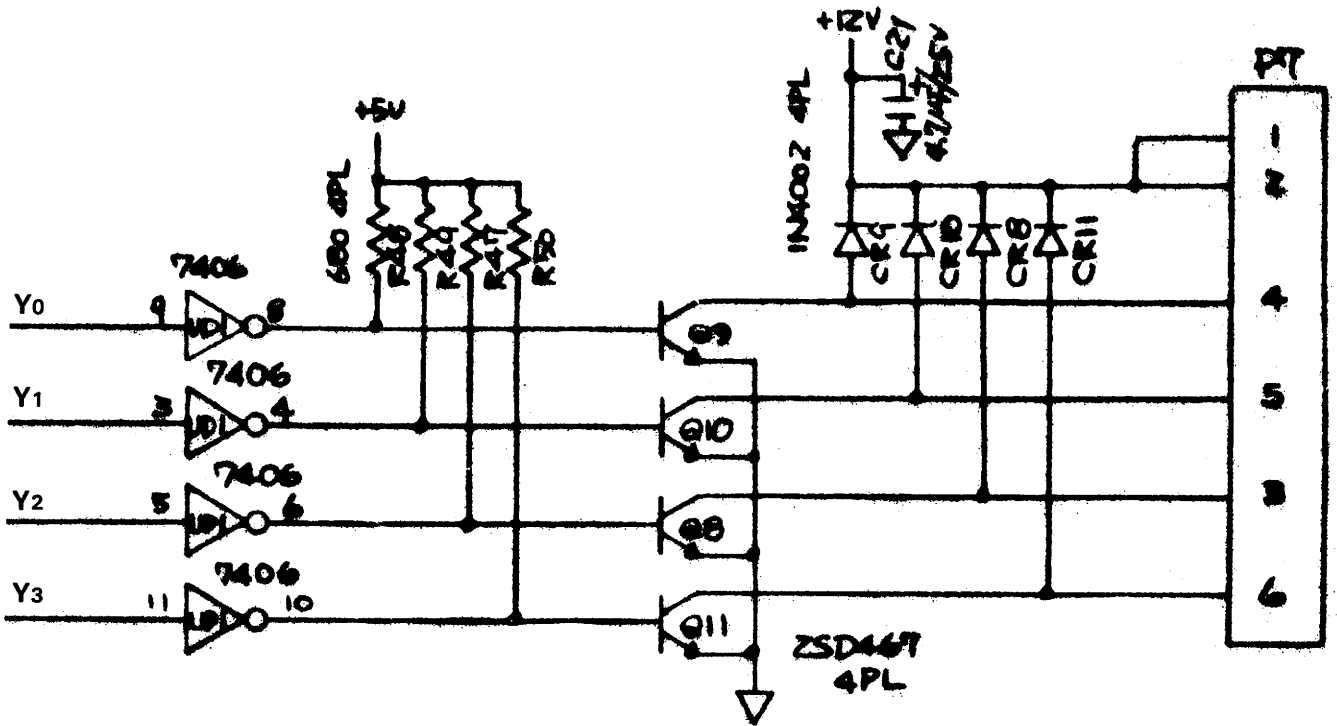
When a write operation occurs, the ERASE coil is energized by forward biasing Q6. This demagnetizes the outer edges of the track, preventing data on one track from bleeding into the next track.



Power Up/Down Write Protection

This circuit prevents erroneous data from being written on the disk during power up/down sequences. During a power up, the 12VDC supply is not applied to the R/W coils and amplifier circuits before the processor has control of the logic. During a power down the 12VDC supply is removed from the R/W coils and amplifier circuits before the processor loses control of the logic.

Q1 acts as a series pass transistor, biased to regulate the 12VF output to the R/W coils and Amplifier circuits. Q2 is a feedback amplifier monitoring the 5VDC supply. CR5 develops a precise reference voltage for Q2. L8 and C15 delay the 12VDC supply.



Stepper Motor Control Circuits

Outputs Y0, Y1, Y2, and Y3 from the PLA are inverted by UD1. The outputs of the inverters drive Q8-Q11. The current output from these transistors drive the individual phase coils in the stepper motor and return to the 12VDC supply. CR8-CR11 suppress the CEMF developed by the motor coils.

MTR output from the PLA is active "low". This signal is passed, through the current driver UD2, to the motor control PCB. When MTR is "low," Q1 is biased off, and Q2, Q3, and Q4 are biased on, allowing current flow through the spindle motor coil. Attached to the shaft of the spindle motor is an inductive tachometer that generates low level AC voltages, as the motor spins. The output of the tachometer is rectified by CR1-CR4. IC 1 monitors the output of the rectifier and adjusts the bias to Q2, which changes the bias on Q3 and Q4 to regulate motor current for a constant velocity. VR1 is a manual speed adjustment. The speed can be adjusted by watching the 60Hz strobe as the adjustment is made or loading the system test from the diagnostic disc.

16

TROUBLESHOOTING GUIDE

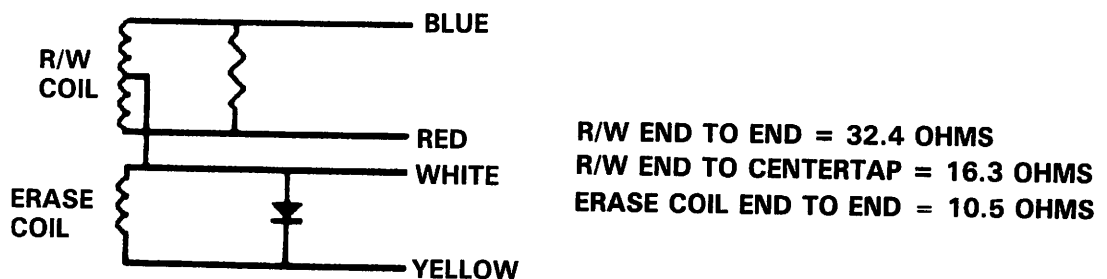
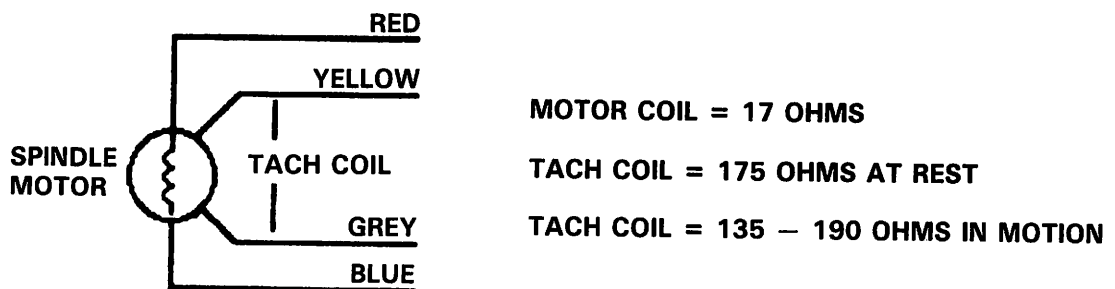
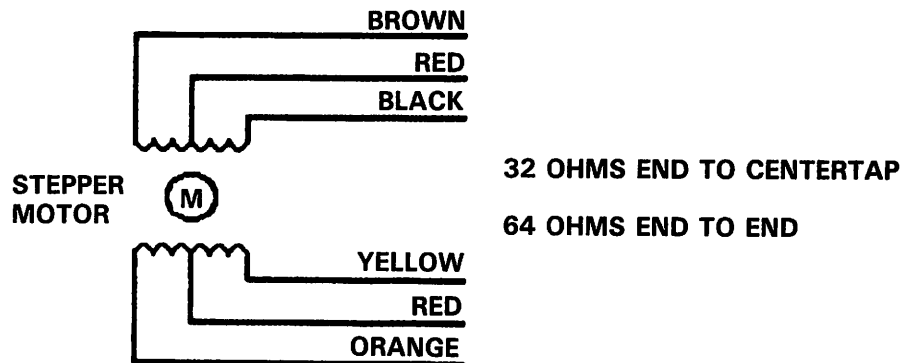
NOTE: Always check for latest ROM/ECO upgrade. If socketed IC is suspected bad, be sure to check socket with ohmmeter.

SYMPTOM:	POSSIBLE SOLUTION:
No LED's on power up.	Is Power cord plugged into wall outlet correctly? Is Power cord plugged into the disk drive correctly? Check line fuse. Check power switch. Check clock on 6502 pin 37. Check +5 and +12 volt lines.
Error LED flashes on power up.	Check all RAM and ROM locations.
Error LED stays on all the time.	Check 6502 microprocessor. Check ROMs.
Drive motor runs continuously and red LED stays on.	Check +12V. Check 6502, logic gates, logic array.
Drive motor runs continuously and red LED stays off.	Check Rom Check drive motor PCB.
Drive motor runs continuously with no red or green LED's.	Check VR2 (5V Regulator). Check Power Transformer.
After the drive warms up the motor runs continuously.	Check 6522s. Check motor control PCB.
Loads programs with red LED flashing.	Check drive speed. Check stepper motor.
Loading is intermittent.	Check ROMs. Check drive alignment.
Does not load when hot or LED flashed 3 times.	Check ROMs.
Searches with LED flashing continuously.	Check ROMs.
Searching with no red LED.	Check 6522s, logic gates, logic array.
Message of 'FILE NOT FOUND' is displayed.	Clean drive head w/alcohol. Check Ø stop adjustment. Check alignment.
Drive fails to read.	Check the 311, 9602, and 592s. There are two +12 volt sources for stepper output and read circuit, make sure both are good.

TROUBLESHOOTING GUIDE (Continued)

SYMPTOM:	POSSIBLE SOLUTION:
Fails to format disk.	Check components related to connector P7. Check 6522s. Check logic array.
Stepper Motor does not step forward.	Check 6502, 6522s, logic array.
Drive speed will not stabilize.	Check DC motor.
Will not save when the drive heats up.	Check 6502 microprocessor.
Locks-up when loading.	Check serial port components. Check ROM.
Fails the performance test and displays a 21 read error.	Check test diskette. Check Drive Motor.
Fails the performance test and displays a 27 read error.	Check stop adjust.
Passes performance test to track 18 then displays 21 read errors.	Check read/write head.
Passes the performance test but will not load certain programs.	Check stepper motor.

RESISTANCE CHECKS



CASEWORK/ACCESSORY PARTS LIST

1540/1541	TOP CASE (IVORY)	C 1540014-01
1540/41	BOTTOM CASE (IVORY)	C 1540015-00
1541	TOP CASE (BROWN)	C 1540014-03
1541	BOTTOM CASE (BROWN)	C 1540015-01
	SHIELD COVER	1540013-01
	LED ASSEMBLY	1540003
	SELF ADHESIVE FOOT	C 950150-02
	1540 NAMEPLATE	C 1540016-01
	1541 NAMEPLATE	C 1540052-01
	POWER CORD ASSEMBLY	C 903508-04
	6 PIN DIN CABLE	C 1515001-01
	USER'S MANUAL	C 1540031-03
	DEMO DISKETTE	C 1540024-01

NOTE: All 1540 Disk Drives were manufactured prior to any changes to the board and used the Alps drive exclusively.

1541 MODEL IDENTIFICATION

- | | |
|-----------------------|---|
| PCB Assy # 1540008-01 | <ul style="list-style-type: none"> • Schematic # 1540001 • Original "Long" Board • Has 4 discreet 2114 RAMs • ALPS Drive only |
| PCB Assy # 1540048 | <ul style="list-style-type: none"> • Schematic # 1540049 • Referred to as the CR board • Changed to 2048 x 8 bit RAM pkg. • A 40 pin Gate Array is used |
| -01 | <ul style="list-style-type: none"> • Alps Drive |
| -03 | <ul style="list-style-type: none"> • Newtronics Drive |
| PCB Assy # 250442-01 | <ul style="list-style-type: none"> • Schematic # 251748 • Termed the 1541 A • Just one jumper change to accommodate both types of drive |
| PCB Assy # 250446-01 | <ul style="list-style-type: none"> • Schematic # 251748 (See Notes) • Termed the 1541 A-2 • Just one jumper change to accommodate both types of drive |

NOTE: The simplest way to identify which drive you have is by the door assembly. Alps is made with a "push down" door and Newtronics has a "flipper" type door.

DEVICE NUMBER CHANGE

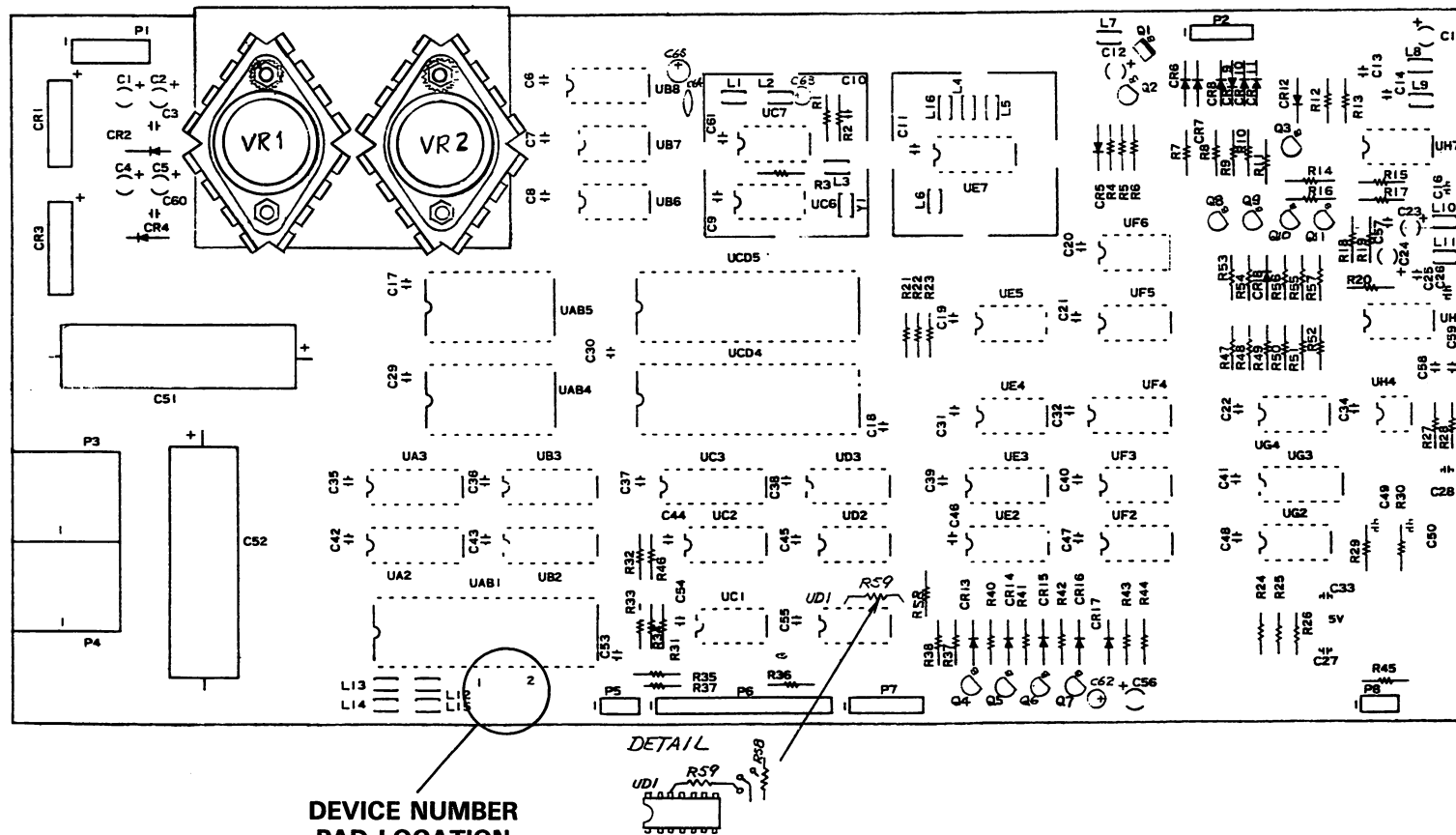
The 1540 and 1541 drives are shipped from the factory set for device # 8. The channel can be hardware altered to # 9, 10, or 11 by two methods:

1) Refer to appropriate board layout drawing for the location of the pads provided for this purpose. The device change pads must be CUT to alter the channel number and re-soldered if another change is needed later.

2) The preferred method to alter the device number is to lift certain pins of the 6522 chip. The I.C. should always be socketed, so removal of the chip is simple. Once removed, the proper pin can be carefully bent to eliminate it from the circuit. If another change is needed, simply remove the I.C. and re-install with the pin back in place.

PCB ASSY #	LOCATION	DEVICE #	LIFT PIN
1540008	UAB1	9	15
1540048,251748	UC3	10	16
and 251834	UC3	11	15 and 16

PCB ASSEMBLY #1540001 BOARD LAYOUT



PARTS LIST

PCB ASSEMBLY #1540001

PLEASE NOTE:

Commodore part numbers are provided for reference only and do not indicate the availability of parts from Commodore. Industry standard parts (Resistors, Capacitors, Connectors) should be secured locally. Approved cross-references for TTL chips, Transistors, etc. will be available in manual form through the Service Department in November of 1984. Unique or non-standard parts will be stocked by Commodore and are indicated on the parts list by a "C".

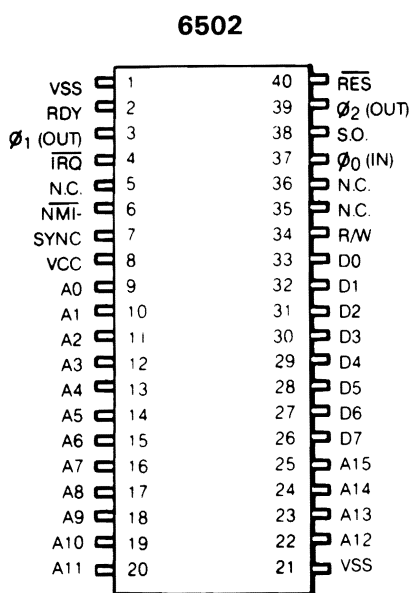
INTEGRATED CIRCUITS			DIODES		
UAB1	6522 VIA	C 901437-01	CR1	Bridge, 1.5A, 50V	900756-01
UAB2	2114 RAM	901471-01	CR2	Rectifier, IN4002	900750-02
UAB3	2114 RAM	901471-01	CR3	Bridge, 4A, 50V	900755-02
UAB4	ROM \$C000-\$DFFF	C 325302-01	CR4	Rectifier, IN4002	900750-02
UAB5	ROM \$E000-\$FFFF (1540)	C 325303-01	CR5	Zener, 3.3V, 500mW, +/- 5%	
UAB5	ROM \$E000-\$FFFF (1541)	C 901229-07		HZ3C-2	325505-01 sub:
UB2	2114 RAM	901471-01		HZ4A-1	325505-02 sub:
UB3	2114 RAM	901471-01		IN5226B	900948-06
UCD4	6522 VIA	C 901437-01	CR6-11	Signal, WG713C	900850-05 sub:
UCD5	6502 CPU	C 901435-01		IN4148	900850-01
UG3	9602	901510-01	CR12	Zener, 5.1V, 500mW, +/- 5%	
UH4	LM311	901523-04		HZ5C-2	325506-01 sub:
UH5	NE 592	901523-08		IN5231	900948-11
UH7	NE 592	901523-08	CR13-16	Rectifier, IN4002	900750-02
TTL			CR17, 18	Signal, WG713C	900850-05 Sub:
UB6	74LS04	901521-02		IN4148	900850-01
UB7	74LS00	901521-01	RESISTORS — All Values are in ohms- 1/4 W		
UB8	74LS42	901521-17	5% unless noted otherwise.		
UC1	74LS14	901521-30	R1, 2	330	
UC2	74LS133	901521-15	R3	47	
UC3	74LS245	901521-45	R4	220	
UC6	74177	901522-03 sub:	R5	330	
	74LS197	901521-54	R6	1K	
UC7	7402	901522-32	R7	22K	
UD1	7406	901522-06	R8	91, Metal Oxide 1/4W, 1%	
UD2	74LS164	901521-28	R9	680	
UD3	74LS165	901521-12	R10	22K	
UE2	74LS139	901521-18	R11	1K	
UE3	74LS191	901521-40	R12, 13	9.1K, Metal Oxide 1/4W, 1%	
UE4	74LS74	901521-06	R14, 15	2.2K	
UE5	74LS02	901521-21	R16, 17	220	
UE7	74LS193	901521-26	R18, 19	150	
UF2	7406	901522-06	R20	330	
UF3	74LS10	901521-24	R21-23	2K	
UF4	74LS193	901521-26	R24	510	
UF5	74LS00	901521-01	R25	360	
UF6	74LS74	901521-06	R26	5.1K	
UG2	74LS86	901521-32	R27, 28	470	
UG4	7417	901522-01 sub:	R29	22K	
	7407	901522-30	R30	360	
TRANSISTORS			R31-34	1K	
Q1	2SA673 PNP	902720-01	R35, 36	100	
Q2, 3	2SC945 NPN	902671-01 sub:	R37	330	
	2SC1815 NPN	902693-01	R38	2K	
Q4, 7	2SD467 NPN	902679-01 sub:	R39-42	680	
	2SC2120 NPN	902682-01	R43	6.8K	
Q8-11	2SA733 PNP	902717-01 sub:	R44	1K	
	2SA1015 PNP	902744-01	R45	220	
			R46	100K	

PARTS LIST PCB ASSEMBLY #1540001 (Continued)

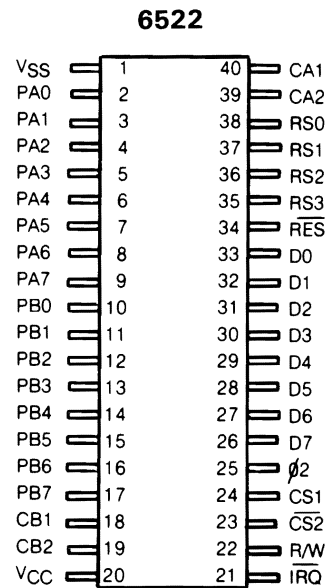
C - Indicates Commodore Stocked Part Number

RESISTORS (Continued)				CAPACITORS (Continued)			
— All values are in ohms- 1/4 W 5% unless noted otherwise.							
R47	470			C51	Electrolytic	6800μF	25V
R48	1.5K			C52	Electrolytic	10000μF	16V
R49	100, Metal Oxide 1/4W, 1 %			C53-55	Ceramic	.1μF	50V
R50	470			C56	Electrolytic	100μF	16V
R51, 52	2.2K			C57	Ceramic	.1μF	50V
R53	22K			C58, 59	Ceramic	.022μF	16V
R54	150, Metal Oxide 1/4W, 1 %			C60, 61	Ceramic	.1μF	50V
R55	470			C62	Tantalum	4.7μF	25V
R56	2.2K			C63	Tantalum	1μF	35V
R57	470			C64	Ceramic	.033μF	25V
R58	1K			C65	Electrolytic	220μF	25V
R59	220			MISCELLANEOUS			
CAPACITORS				L1	Coil Inductor 2.2μH		
C1	Electrolytic	1μF	25V	L2-6	Ferrite Bead (2743005112)		
C2	Electrolytic	47μF	16V	L7	Coil Inductor 100μH		
C3	Ceramic	.1μF	50V	L8	Coil Inductor 22μH		
C4	Electrolytic	1μF	25V	L9, 10	Coil Inductor 100μH		
C5	Electrolytic	47μF	16V	L11	Coil Inductor 22μH		
C6-9	Ceramic	.1μF	50V	L12-16	Ferrite Bead (2743005112)		
C10	Ceramic	68pF	50V	VR1	Voltage Reg 12V, 1.5A (LM340K-12 TO-3)		
C11	Ceramic	.1μF	50V	VR2	Voltage Reg 5V, 1.2A (LM340K-5 TO-3) Sub:		
C12	Tantalum	10μF	25V		5V, 3A (LM323)		
C13, 14	Ceramic	.1μF	50V	Y1	Crystal 16MHz	900556-02	
C15	Tantalum	.47μF	16V +/- 20%		Shield Box	4022048-01	
C16	Ceramic	680 pF	50V +/- 5%		Shield Cap	4022047-01	
C17-22	Ceramic	.1μF	50V	CONNECTORS			
C23	Tantalum	3.3μF	25V	P1	Header Assy, 3.96 Pitch, 4Pin	(Mole 5271-04A)	
C24	Tantalum	.47μF	16V +/- 20%	P2, 3	6 Pin Din,		
C25	Ceramic	.1μF	50V		(Hoshidenki TSC4460-01-101	C 903361-01	
C26	Ceramic	1000pF	50V	P4, 5	Header Assy, 2.5 Pitch, 3Pin	(Molex 3022-03A)	
C27	Ceramic	680pF	50V +/- 5%	P6	Header Assy, 2.5 Pitch, 15Pin	(Molex 3022-15A)	
C28	Ceramic	330pF	50V +/- 5%	P7	Header Assy, 2.5 Pitch, 6Pin	(Molex 3022-06A)	
C29-32	Ceramic	.1μF	50V	P8	Header Assy, 2.5 Pitch, 4Pin	(Molex 5048-04AG)	
C33	Ceramic	33pF	50V				
C34-48	Ceramic	.1μF	50V				
C49	Ceramic	330pF	50V +/- 5%				
C50	Ceramic	680pF	50V +/- 5%				

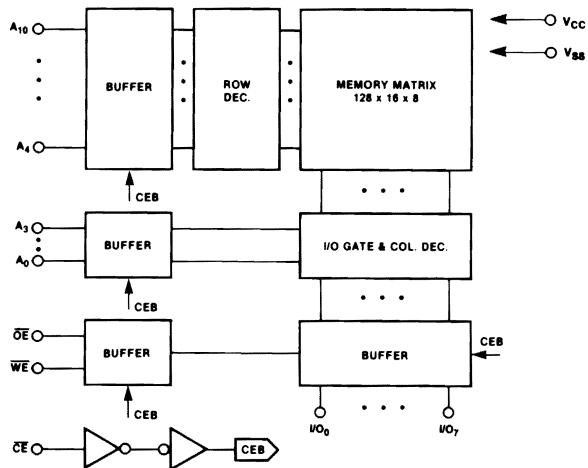
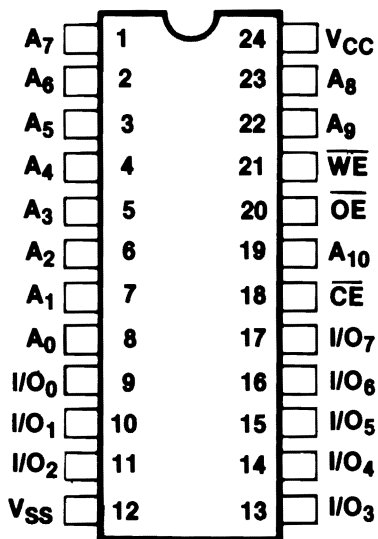
PIN CONFIGURATIONS:



901435-01
Microprocessor



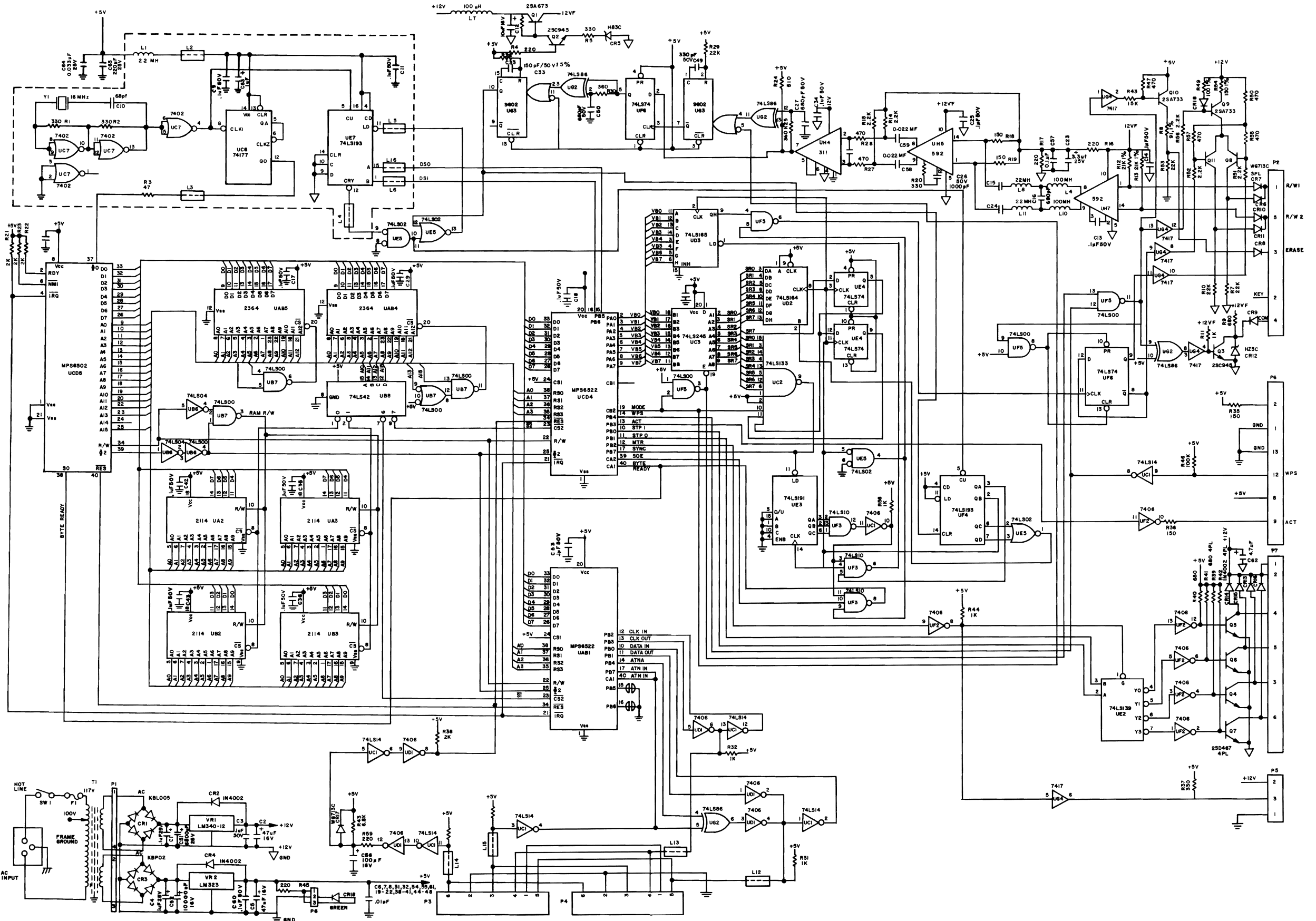
901437-01
Versatile Interface
Adapter (VIA)



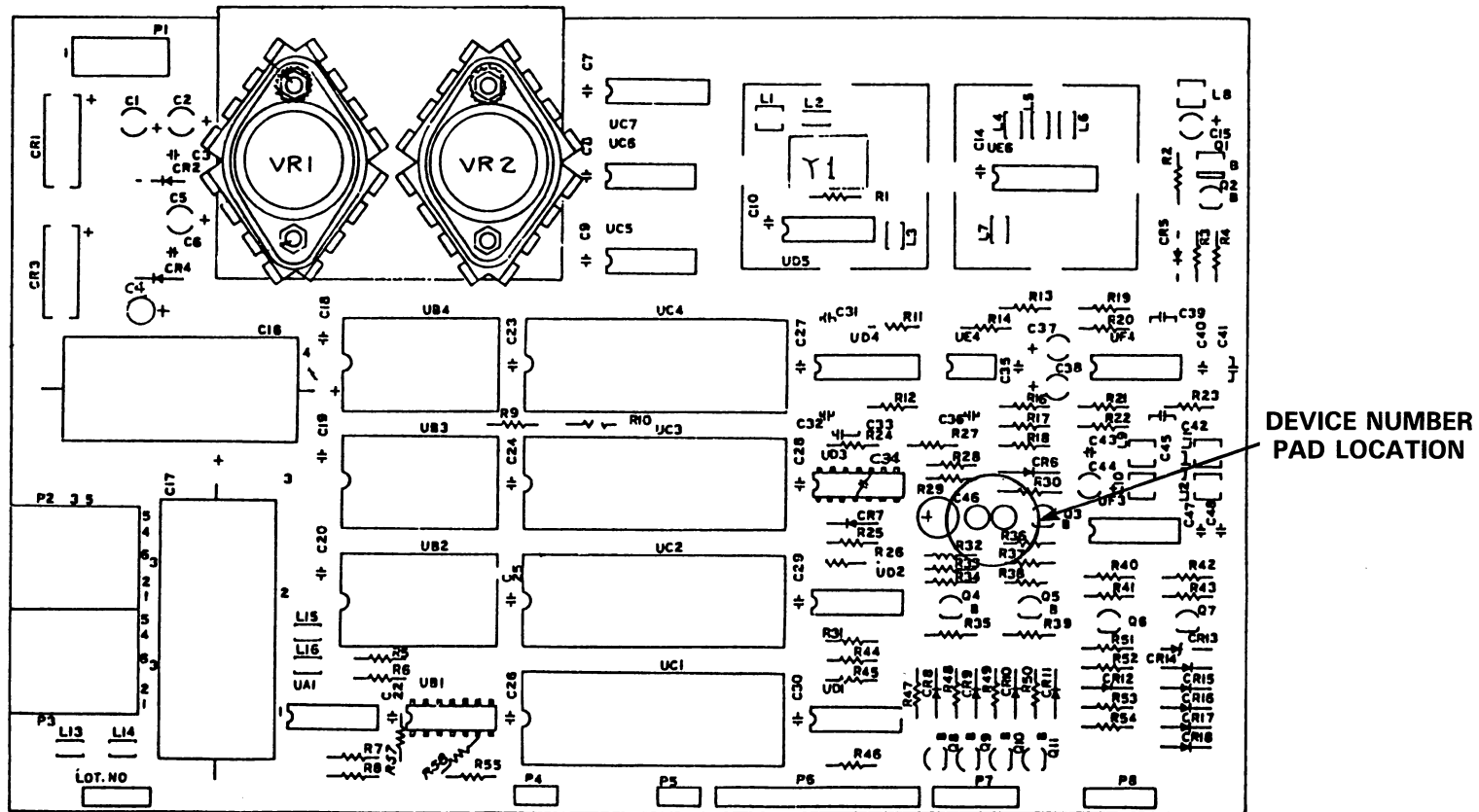
2048 X 8 STATIC RAM

Approved Replacements	
Mitsubishi	M58725P
Toshiba	TMM2016P
Hitachi	HM6116LP-4/AP-20

SCHEMATIC #1540008



PCB ASSY #1540048 BOARD LAYOUT



PARTS LIST

PCB ASSEMBLY #1540048

PLEASE NOTE:

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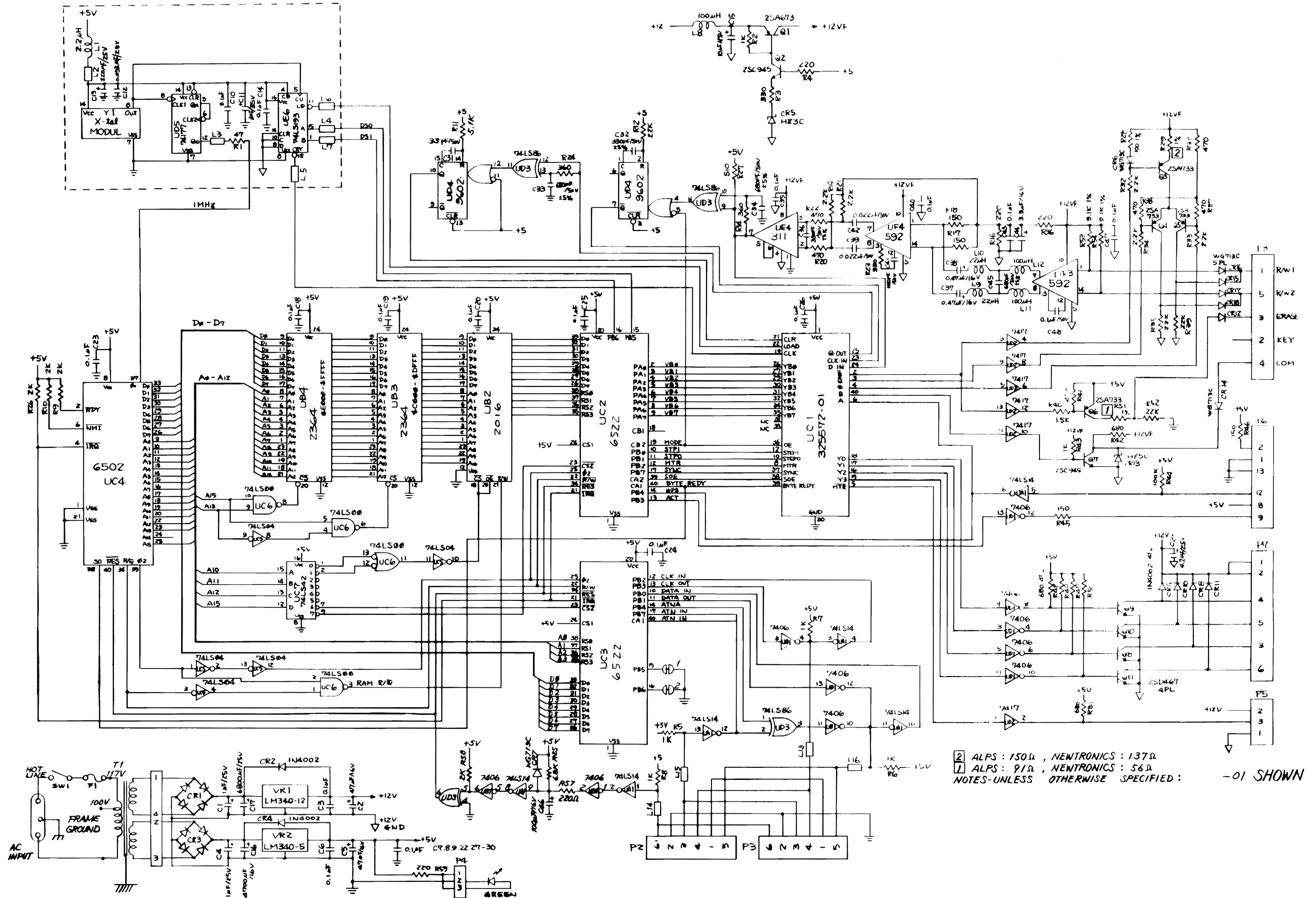
INTEGRATED CIRCUITS				DIODES		
UB2	TMM2016P RAM	325502-03	sub:	CR1	Bridge, 1.5A, 50V	900756-01
	M58725P RAM	325502-01	sub:	CR2	Rectifier, IN4002	900750-02
	HM6116P4	325502-08		CR3	Bridge, 1.5A, 50V	900756-01
UB3	ROM \$C000-\$DFFF	C 325302-01		CR4	Rectifier, IN4002	900750-02
UB4	ROM \$E000-\$FFFF	C 901229-05		CR5	Zener, 3.3V, 500mW, +/- 5%	
UC1	GATE ARRAY	C 325572-01			HZ3C-2	325505-01 sub:
UC2	6522 VIA	C 901437-01			HZ4A-1	325505-02 sub:
UC3	6522 VIA	C 901437-01			IN5226B	900948-06
UC4	6502 CPU	C 901435-01		CR6, 7	Signal, WG713C	900850-05 sub:
UD4	9602	901510-01			IN4148	900850-01
UE4	LM311	901523-04		CR8-11	Rectifier, IN4002	900750-02
UF3	NE 592	901523-08		CR12	Signal, WG713C	900850-05 sub:
UF4	NE 592	901523-08			IN4148	900850-01
TTL				CR13	Zener, 5.1V, 500mW, +/- 5%	
UA1	74LS14	901521-30			HZ5C-2	325506-01 sub:
UB1	7406	901522-06	sub:		IN5231	900948-11
	7707	251749-01		CR14-18	Signal, WG713C	900850-05 Sub:
UC5	74LS04	901521-02	sub:		IN4148	900850-01
	7713	251749-02	sub:	RESISTORS — All Values are in ohms- 1/4 W		
	74LS14	901521-30	sub:	5% unless noted otherwise.		
	7414	901522-19		R1	47	
UC6	74LS00	901521-01		R2	1K	
UC7	74LS42	901521-17		R3	330	
UD1	7406	901522-06		R4	220	
UD2	7417	901522-01	sub:	R5-8	1K	
	7407	901522-30		R9, 10	2K	
UD3	74LS86	901521-32		R11	5.1K	
UD5	74LS197	901521-54	sub:	R12	22K	
	74177	901522-03		R14	360	
UE6	74LS193	901521-26		R16	220	
TRANSISTORS				R17, 18	150	
Q1	2SA673	PNP	902720-01	R19	2.2K	
Q2	2SC945	NPN	902671-01	R20	470	
	2SC1815	NPN	902693-01	R21	2.2K	
Q3-6	2SA733	PNP	902717-01	R22	470	
	2SA1015	PNP	902744-01	R23	330	
Q7	2SC945	NPN	902671-01	R24	360	
	2SC1815	NPN	902693-01	R25	6.8K	
Q8-11	2SD467	NPN	902679-01	R26	2K	
	2SC2120	NPN	902682-01	R27	510	
				R28	100 @ 1%	
				R29	150 @ 1% (ALPS)	
					137 @ 1% (NEWTRONICS)	
				R30	470	
				R31	680	
				R32-34	2.2K	
				R35	22K	
				R36	220	
				R37, 38	470	
				R39	22K	

PARTS LIST PCB ASSEMBLY #1540048 (Continued)

C - Indicates Commodore Stocked Part Number

RESISTORS (Continued)		CAPACITORS (Continued)	
— All Values are in ohms- 1/4 W 5% unless noted otherwise.			
R40	1.5K	C39	Ceramic .022 μ F, 16V
R41	470	C40	Ceramic .1 μ F, 50V
R42	680	C41	Ceramic 1000pF, 50V
R43	1K	C42	Ceramic .022 μ F, 16V
R44	100K	C43	Ceramic .1 μ F, 50V
R45, 46	150	C44	Tantalum 3.3 μ F, 25V
R47-50	680	C45	Ceramic 680pF, 50V +/- 5%
R51	91 @ 1% (ALPS)	C46	Electrolytic 100 μ F, 16V
	56 @ 1% (NEWTRONICS)	C47,48	Ceramic .1 μ F, 50V
R52	22K	MISCELLANEOUS	
R53, 54	9.1K @ 1%	L1	Coil Inductor 2.2 μ H
R55	220	L2-7	Ferrite Bead (2743005112)
R57	220	L8	Coil Inductor 100 μ H
R58	2K	L9,10	Coil Inductor 22 μ H
CAPACITORS		L11,12	Coil Inductor 100 μ H
C1	Electrolytic 1 μ F, 25V	L13-16	Ferrite Bead
C2	Electrolytic 47 μ F, 16V	VR1	Voltage Reg 12V, 1.5A (LM340K-12 TO-3)
C3	Ceramic .1 μ F, 50V	VR2	Voltage Reg 5V, 1.2A (LM340K-5 TO-3) Sub: 5V, 3A (LM323)
C4	Electrolytic 1 μ F, 25V	Y1	Crystal Module 16MHz 50ppm (NDK, Tyocom) Sub: 16MHz 100ppm (NDK, Tyocom, Kyocera)
C5	Electrolytic 47 μ F, 16V		Shield Box C 4022048-01
C6-10	Ceramic .1 μ F, 50V		Shield Cap C 4022047-01
C11	Tantalum 1 μ F, 35V	CONNECTORS	
C12	Ceramic .033 μ F, 25V	P1	Header Assy, 3.96 Pitch, 4Pin (Molex 5271-04A)
C13	Electrolytic 220 μ F, 10V	P2, 3	6 Pin Din, C 903361-01
C14	Ceramic .1 μ F, 50V	P4, 5	Header Assy, 2.5 Pitch, 3Pin (Molex 3022-03A)
C15	Tantalum 10 μ F, 25V	P6	Header Assy, 2.5 Pitch, 15Pin (Molex 3022-15A)
C16	Electrolytic 4700 μ F, 16V	P7	Header Assy, 2.5 Pitch, 6Pin (Molex 3022-06A)
C17	Electrolytic 6800 μ F, 25V	P8	Header Assy, 2.5 Pitch, 4Pin (Molex 5048-04AG)
C18-20	Ceramic .1 μ F, 50V		
C21	Tantalum 4.7 μ F, 25V		
C22-30	Ceramic .1 μ F, 50V		
C31	Ceramic 33pF, 50V +/- 5%		
C32	Ceramic 330pF, 50V +/- 5%		
C33, 34	Ceramic 680pF, 50V +/- 5%		
C35	Ceramic .1 μ F, 50V		
C36	Ceramic 330pF, 50V +/- 5%		
C37-38	Tantalum .47 μ F, 16V		

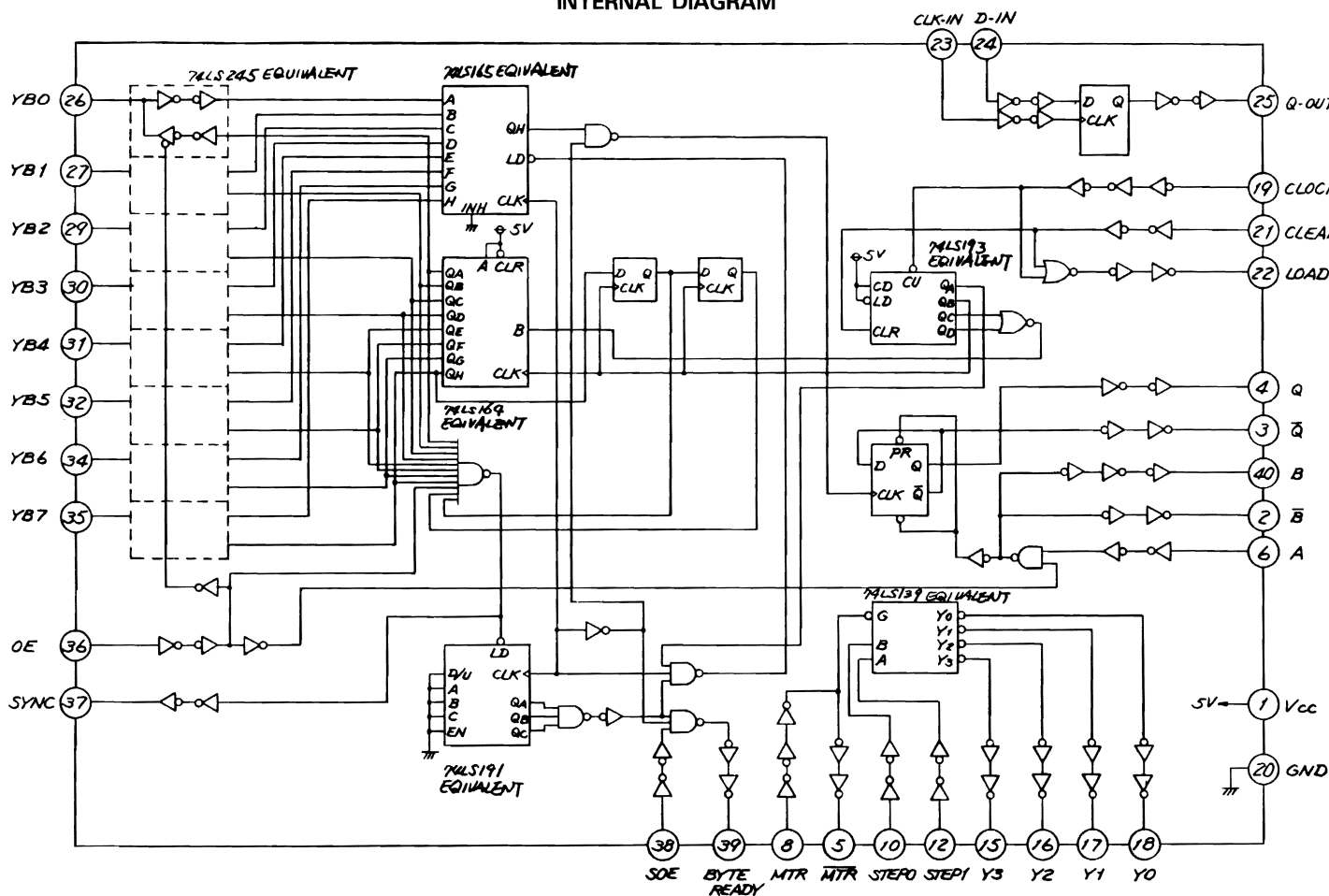
SCHEMATIC #1540049



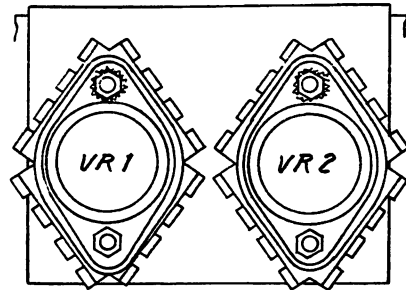
VCC	1	40	B
$\bar{B}$	2	39	BYTE READY
$\bar{O}$	3	38	SOE
Q	4	37	SYNC
$\overline{MTR}$	5	36	OE
A	6	35	YB7
N.C.	7	34	YB6
$\overline{MTR}$	8	33	N.C.
N.C.	9	32	YB5
STERO	10	31	YB4
N.C.	11	30	YB3
STEP1	12	29	YB2
N.C.	13	28	N.C.
N.C.	14	27	YB1
Y3	15	26	YB0
Y2	16	25	Q-OUT
Y1	17	24	D-IN
Y0	18	23	CLK-IN
CLOCK	19	22	LOAD
GND	20	21	CLEAR

PN 325572 GATE ARRAY FOR FLOPPY DISK DRIVE

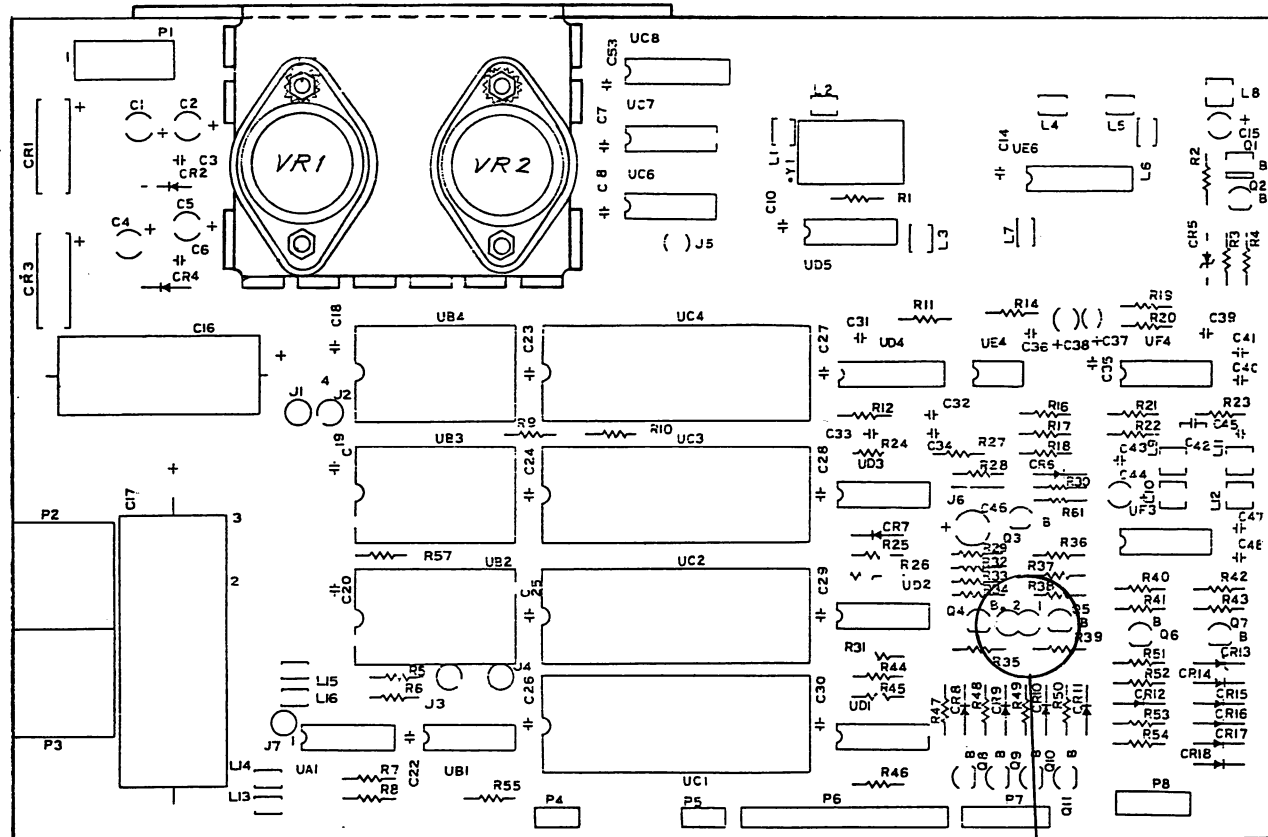
INTERNAL DIAGRAM



PCB ASSEMBLY #250442/46 BOARD LAYOUT



SUBSTITUTE HEATSINK



DEVICE
NUMBER
PAD
LOCATION

PARTS LIST

PCB ASSEMBLY #250442/46

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INTEGRATED CIRCUITS				DIODES (Continued)		
UB2	TMM2016P RAM	325502-03	sub:	CR6, 7	Signal, WG713C	900850-05 sub:
	M58725P RAM	325502-01	sub:		IN4148	900850-01
	HM6116P4	325502-08		CR8-11	Rectifier, IN4002	900750-02
UB3	ROM \$C000-\$DFFF	C 325302-01		CR12	Signal, WG713C	900850-05 sub:
UB4	ROM \$E000-\$FFFF	C 901229-05			IN4148	900850-01
UC1	GATE ARRAY	C 325572-01		CR13	Zener, 5.1V, 500mW, +/- 5%	
UC2	6522 VIA	C 901437-01			HZ5C-2	325506-01 sub:
UC3	6522 VIA	C 901437-01			IN5231	900948-11
UC4	6502 CPU	C 901435-01		CR14-18	Signal, WG713C	900850-05 Sub:
UD4	9602 (250442)	901510-01	sub:		IN4148	900850-01
	74LS123 (250446)	901521-49		RESISTORS — All values are in ohms- 1/4 W		
UE4	LM311	901523-04		5% unless noted otherwise.		
UF3	NE 592	901523-08		R1	47	
UF4	NE 592	901523-08		R2	1K	
TTL				R3	330	
UA1	74LS14	901521-30		R4	220	
UB1	7406	901522-06	sub:	R5-8	1K	
	74LS06	901521-73		R9, 10	2K	
UC5	74LS04	901521-02	sub:	R11	5.1K	
	74LS14	901521-30	sub:	R12	22K (250442)	
	7414	901522-19			15K	
UC7	74LS00	901521-01		R14	360 (250446)	
UC8	74LS42	901521-17		R16	220	
UD1	7406	901522-06	sub:	R17, 18	150	
	74LS06	901521-73		R19	2.2K	
UD2	7417	901522-01	sub:	R20	470	
	7407	901522-30		R21	2.2K	
UD3	74LS86	901521-32		R22	470	
UD5	74LS197	901521-54	sub:	R23	330	
	74177	901522-03		R24	360	
UE6	74LS193	901521-26		R25	6.8K	
TRANSISTORS				R26	2K	
Q1	2SA673 PNP	902720-01		R27	510	
Q2	2SC945 NPN	902671-01	sub:	R28	100 @ 1%	
	2SC1815 NPN	902693-01		R29	137 @ 1%	
Q3-6	2SA733 PNP	902717-01	sub:	R30	470	
	2SA1015 PNP	902744-01		R31	680	
Q7	2SC945 NPN	902671-01	sub:	R32-34	2.2K	
	2SC1815 NPN	902693-01		R35	22K	
Q8-11	2SD467 NPN	902679-01	sub:	R36	220	
	2SC2120 NPN	902682-01		R37, 38	470	
DIODES				R39	22K	
CR1	Bridge, 1.5A, 50V	900756-01		R40	1.5K	
CR2	Rectifier, IN4002	900750-02		R41	470	
CR3	Bridge, 1.5A, 50V	900756-01		R42	680	
CR4	Rectifier, IN4002	900750-02		R43	1K	
CR5	Zener, 3.3V, 500mW, +/- 5%			R44	100K	
	HZ3C-2	325505-01	sub:	R45, 46	150	
	HZ4A-1	325505-02	sub:	R47-50	680	
	IN5226B	900948-06		R51	56 @ 1%	
				R52	22K	
				R53, 54	10K	
				R55	220	
				R57	220	
				R61	13 @ 1%	

PARTS LIST PCB ASSEMBLY #250442/46 (Continued)

C - Indicates Commodore Stocked Part Number

CAPACITORS			MISCELLANEOUS		
C1	Electrolytic	1 μ F, 25V	L1	Coil Inductor	2.2 μ H
C2	Electrolytic	47 μ F, 16V	L2-7	Ferrite Bead (2743005112)	
C3	Ceramic	.1 μ F, 50V	L8	Coil Inductor	100 μ H
C4	Electrolytic	1 μ F, 25V	L9,10	Coil Inductor	22 μ H
C5	Electrolytic	47 μ F, 16V	L11,12	Coil Inductor	100 μ H
C6-10	Ceramic	.1 μ F, 50V	VR1	Voltage Reg	12V, 1.5A (LM340K-12 TO-3)
C11	Tantalium	1 μ F, 35V	VR2	Voltage Reg	5V, 1.2A (LM340K-5 TO-3) Sub: 5V, 3A (LM323)
C12	Ceramic	.033 μ F, 25V	Y1	Crystal Module	16MHz 50ppm (NDK, Tyocom) Sub: 16MHz 100ppm (NDK, Tyocom, Kyocera)
C13	Electrolytic	220 μ F, 10V	CONNECTORS		
C14	Ceramic	.1 μ F, 50V	P1	Header Assy, 3.96 Pitch,	4Pin (Molex 5271-04A)
C15	Tantalium	10 μ F, 25V	P2, 3	6 Pin Din,	C 903361-01
C16	Electrolytic	4700 μ F, 16V	P4, 5	Header Assy, 2.5 Pitch,	3Pin (Molex 3022-03A)
C17	Electrolytic	6800 μ F, 25V	P6	Header Assy, 2.5 Pitch,	15Pin (Molex 3022-15A)
C18-20	Ceramic	.1 μ F, 50V	P7	Header Assy, 2.5 Pitch,	6Pin (Molex 3022-06A)
C21	Tantalium	4.7 μ F, 25V	P8	Header Assy, 2.5 Pitch,	4Pin (Molex 5048-04AG)
C22-30	Ceramic	.1 μ F, 50V			
C31	Ceramic	33pF, 50V +/- 5%			
C32	Ceramic	330pF, 50V +/- 5%			
C33,34	Ceramic	680pF, 50V +/- 5%			
C35	Ceramic	.1 μ F, 50V			
C36	Ceramic	330pF, 50V +/- 5%			
C37,38	Tantalium	.47 μ F, 16V			
C39	Ceramic	.022 μ F, 16V			
C40	Ceramic	.1 μ F, 50V			
C41	Ceramic	1000pF, 50V			
C42	Ceramic	.022 μ F, 16V			
C43	Ceramic	.1 μ F, 50V			
C44	Tantalium	3.3 μ F, 25V			
C45	Ceramic	680pF, 50V +/- 5%			
C46	Electrolytic	100 μ F, 16V			
C47,48	Ceramic	.1 μ F, 50V			

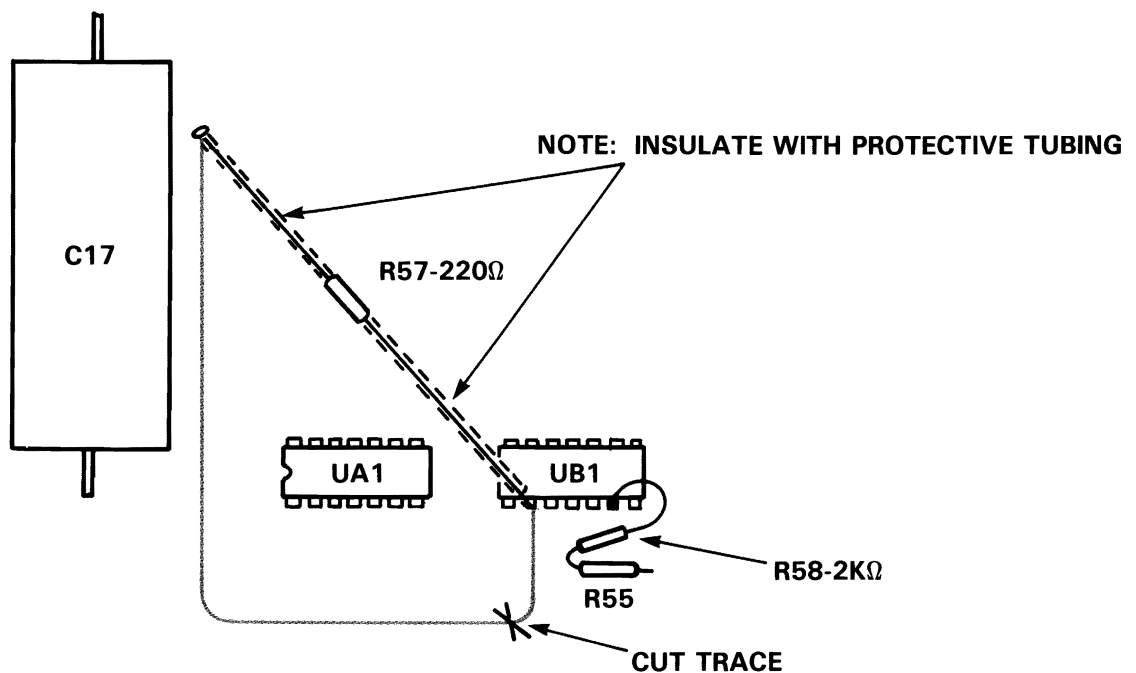
UPGRADE NOTES

PCB Assembly # 1540048 (Schematic 1540049) requires an upgrade to the reset circuit. The upgrade consists of:

1) COMPONENT CHANGES:

R25	Change To	6.8K ohm,	1/4 W, +/− 5%
R57	Add	220 ohm,	1/4 W, +/− 5%
R58	Add	2K ohm,	1/4 W, +/− 5%

2) CUT circuit trace near UA1 (See diagram)



3) INSTALL JUMPER WIRES:

BETWEEN:

- UA1 pin 8 and UB1 pin 5
- UA1 pin 9 and CR7 Anode
- UB1 pin 6 and UD3 pin 5 on BACK of board

4) CUT circuit trace between CR7 Anode and UD3 pin 5 on BACK of board.

NEWTRONICS – SHORT J6
ALPS – J6 IS OPEN



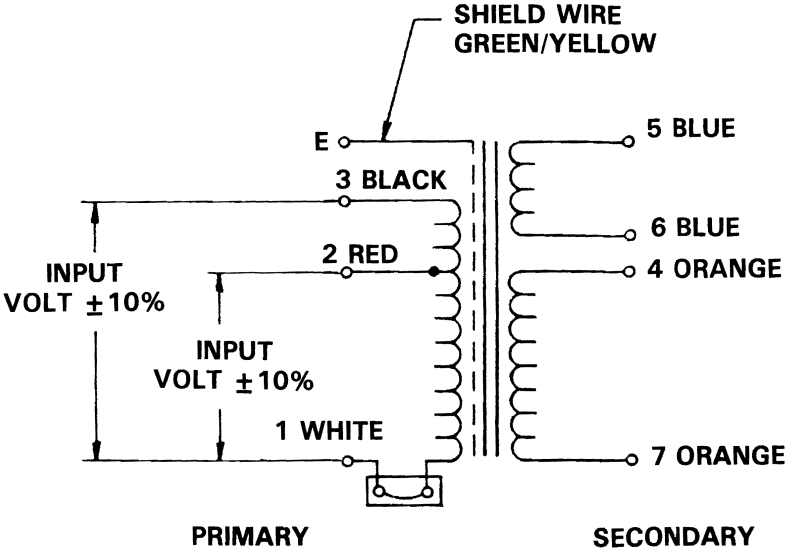
Schematic #251748 can be used for two board assembly numbers. The changes for each assembly number are:

Component	PCB Assy #250442	PCB Assy #250446
UD4	9602	74LS123
R12	22K	15K
C31	33pF	Eliminated

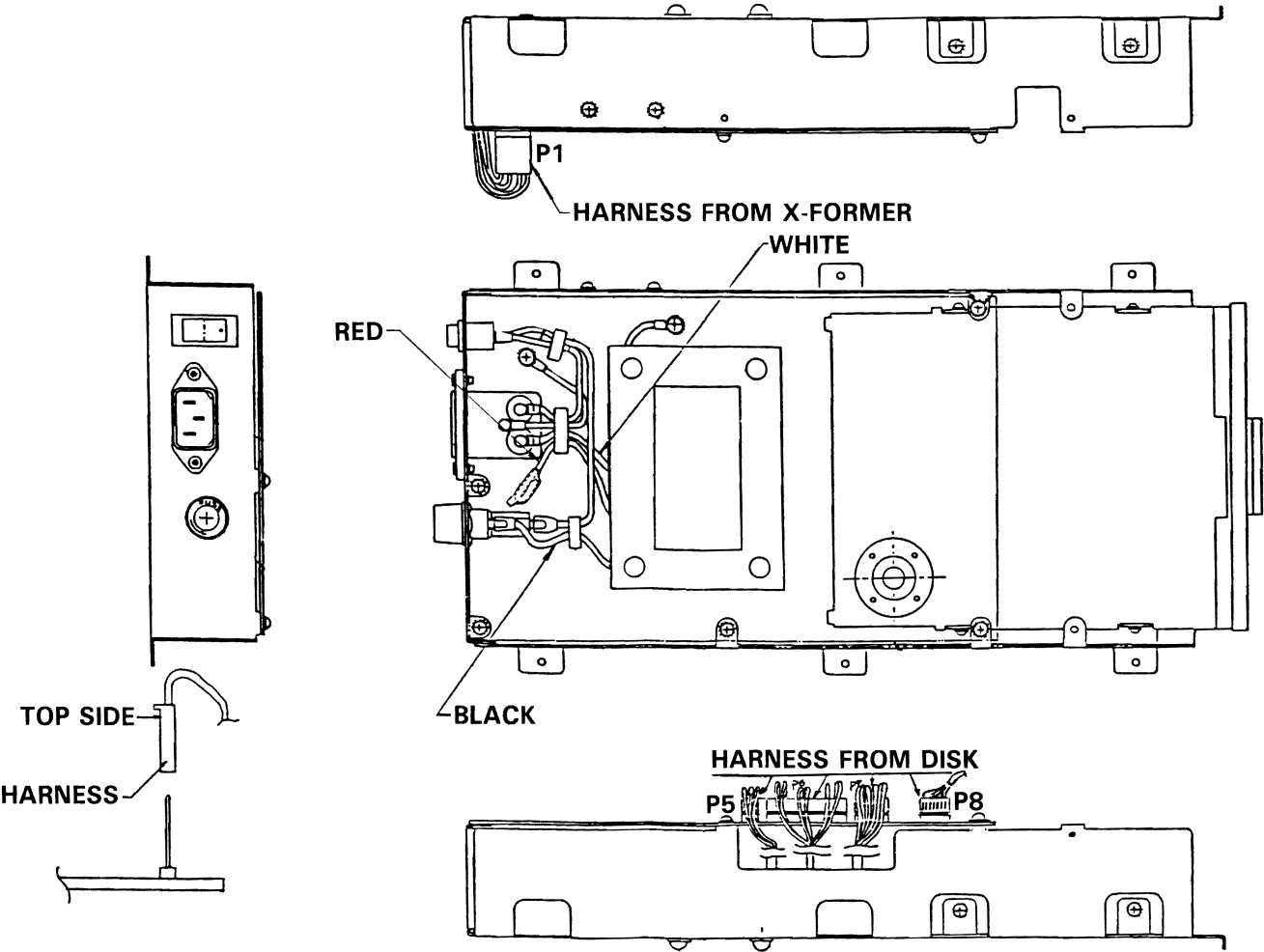
PCB Assembly #250442 is shown here.

1540/1541 POWER SUPPLY ASSEMBLY
PARTS LIST

FUSE HOLDER	903614-01
ROCKER SWITCH	904509-01
POWER CNNCT FILTER	903467-03 sub:
	325552-01
FUSE, SLOW BLO, 250V, 1.0A	903556-16
POWER TRANSFORMER	1540009-02



TRANSFORMER



ASSEMBLY DRAWING

ALPS DRIVE ASSEMBLIES 1540/1541

PARTS LIST

32551901 Alps Drive (Black)

32551902 Alps Drive (Brown)

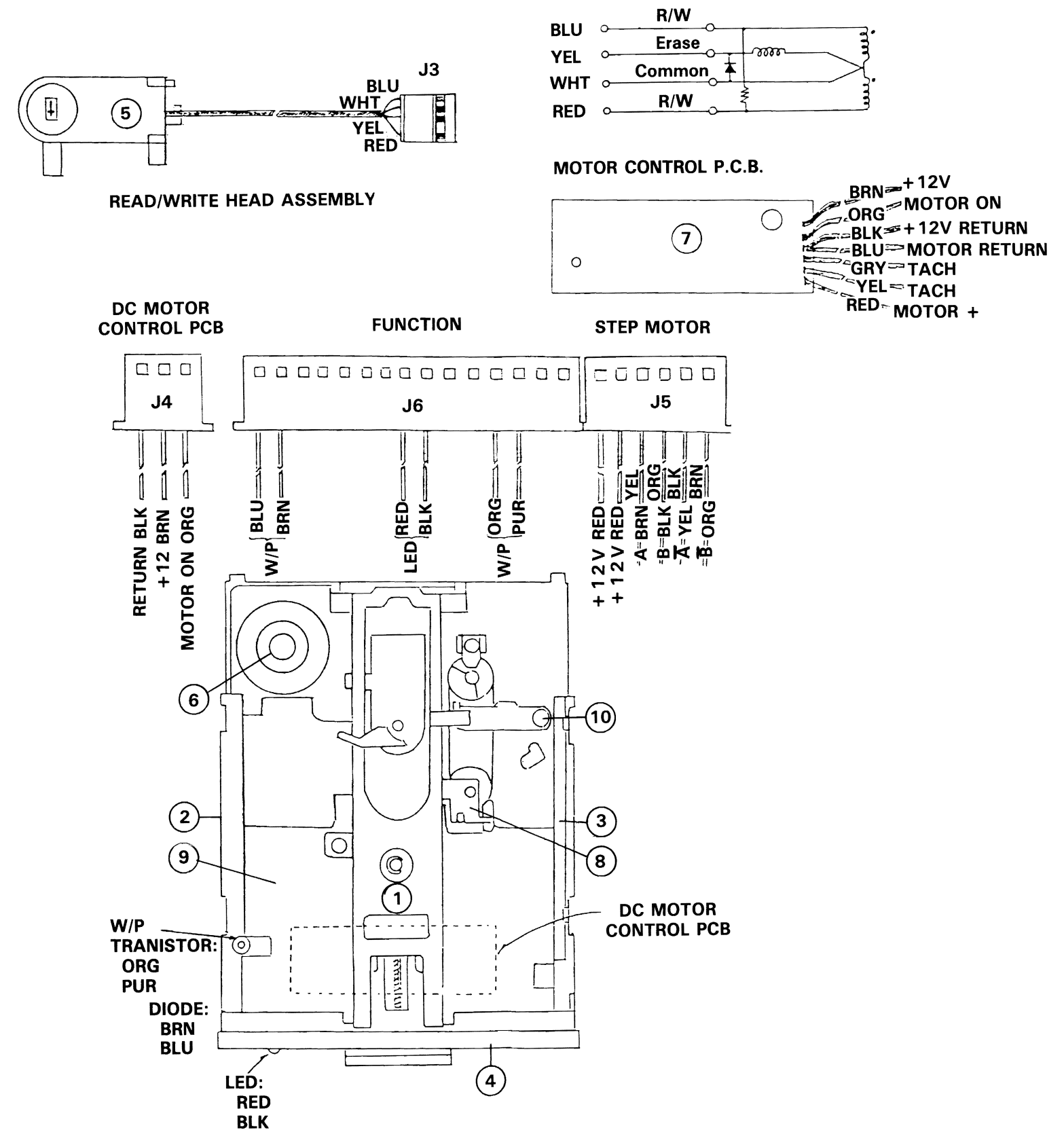
- | | | | |
|---|--|---|---|
| ① | 31410001 ALP DOOR/HUB ASSEMBLY
1-Door Assy w/Spring
2-Hub/Collet Assy
3-Arm Support Assy | ⑦ | 31410701 ALP MOTOR CONTROL PCB ASSEMBLY
1-Motor Control PCB
2-Harness Assy |
| ② | 31410101 ALP LEFT DISK GUIDE ASSEMBLY
1-Diskette Guide
2-LED Assy w/Harness
3-Write Protect Assy | ⑧ | 31410801 ALP TENSION PULLEY ASSEMBLY
1-Pulley Wheel w/Spring
2-Plastic Housing |
| ③ | 31410201 ALP RIGHT DISK GUIDE | ⑨ | 31410901 ALP HOUSING/SPINDLE ASSEMBLY
1-Housing Base
2-Spindle Assy
3-L/R Guide Shafts |
| ④ | 31410301 ALP FRONT BEZEL (Black)

31410302 ALP FRONT BEZEL (Brown) | | 31411001 ALP DRIVE BELT |
| ⑤ | 31410401 ALP R/W HEAD ASSEMBLY
1-R/W Head
2-Load Arm w/Pad
3-Metal Band

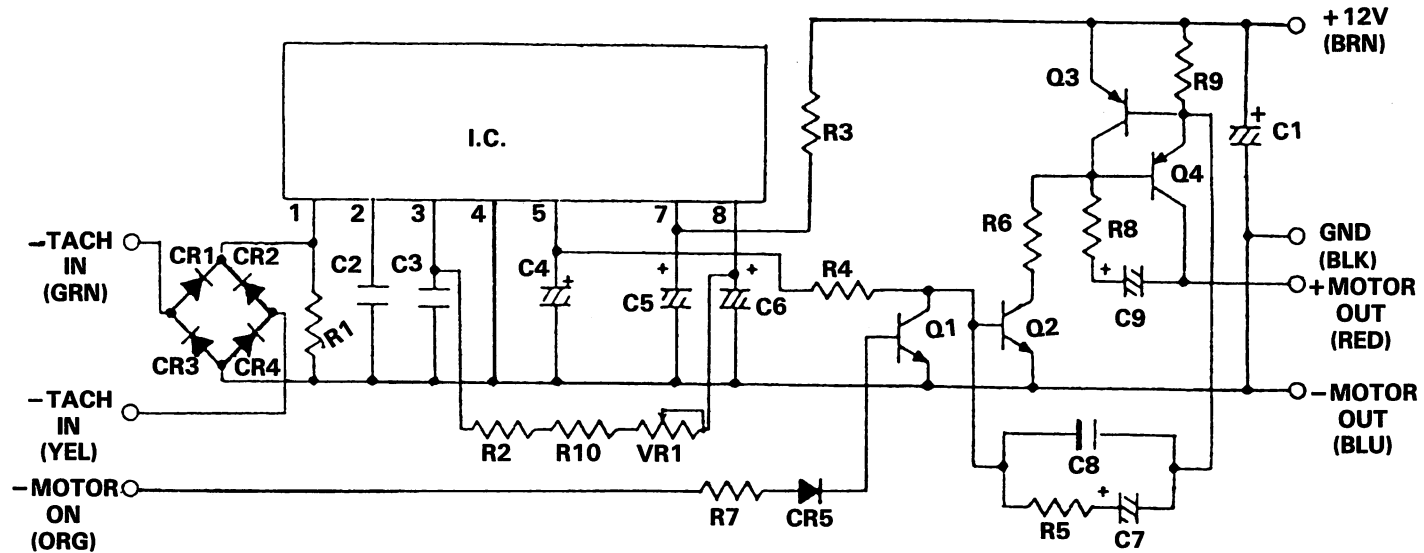
31410501 ALP STEPPER MOTOR ASSEMBLY
1-Stepper Motor w/Harness
2-Stepper Pulley | ⑩ | 31411101 ALP EJECT ASSEMBLY
1-Eject Plate
2-Eject Spring

31411201 ALP HARDWARE
1-Assorted Screws
2-Zero Stop Tab

31417401 UNIV Replacement Load Pad |
| ⑥ | 31410601 ALP D.C. MOTOR | | |



ALPS MOTOR CONTROL BOARD SCHEMATIC



<u>SYMBOL</u>	<u>DESCRIPTION</u>
I.C.	Sony CX-065B
Q1	Transistor 2SC2785
Q2	Transistor 2SC2785
Q3	Transistor 2SA1175
Q4	Transistor B703-Q36E
CR1,2,3,4,5	Diode IN4148
R1,7	Resistor, 1k Ω , 1/4W
R2	Resistor, 68k Ω , 1/4W
R3	Resistor, 220 Ω , 1/4W
R4	Resistor, 3.3k Ω , 1/4W
R5	Resistor, 2.7k Ω , 1/4W

R6	Resistor, 820 Ω , 1/4W
R8	Resistor, 150 Ω , 1/4W
R9	Resistor, 0.68 Ω , 2W
R10	Resistor, 5.1k μ , 1/8W
VR1	Variable Resistor, 20k Ω
C1,5,6	Capacitor, Electrolytic, 10 μ F, 35V
C2	Capacitor, 0.0047 μ F, 50V
C3	Capacitor, 0.033 μ F, 50V
C4,9	Capacitor, Tantalum, 0.47 μ F, 35V
C7	Capacitor, Tantalum, 2.2 μ F, 16V
C8	Capacitor, 0.068 μ F, 50V

PARTS LIST

NEWTRONICS DRIVE ASSEMBLY
1541

#251643-01 NEWTRONICS DRIVE (Brown)

#251643-02 NEWTRONICS DRIVE (Dk. Grey)

- ①

314120-01 NWT DOOR/LATCH ASSEMBLY
1-Top Plate w/Latch Spring & Cam
2-Latch Knob w/Allen Screws
- ②

314121-01 NWT HUB FRAME ASSEMBLY
1-Hub/Collet Assy
2-Hub Frame
- ③

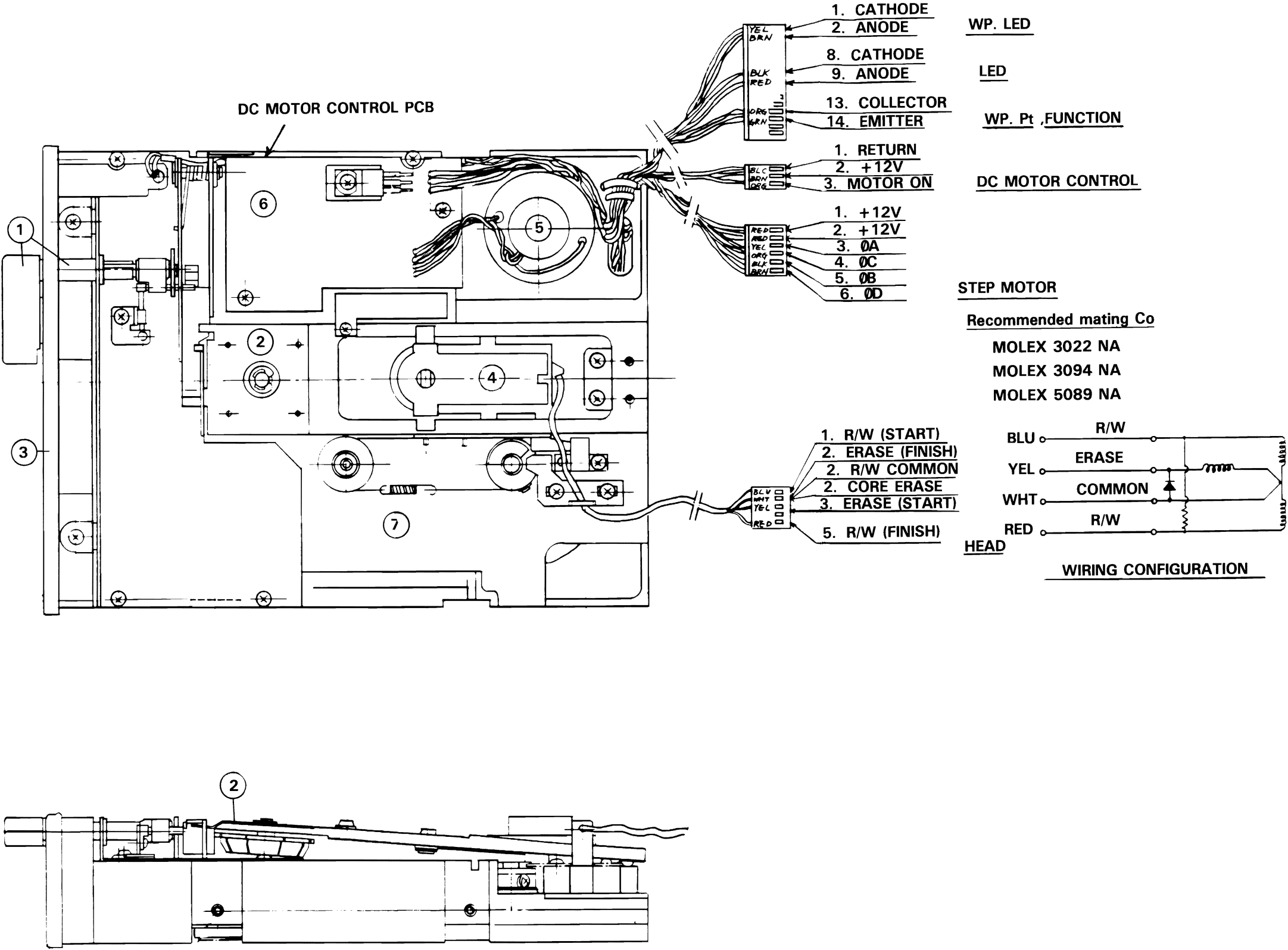
314122-01 NWT FRONT BEZEL ASSEMBLY
1-Front Bezel w/LED & Harness
2-Write Protect Assy
- ④

314123-01 NWT R/W HEAD ASSEMBLY
1-R/W Head
2-Load Arm w/Pad
3-Metal Band
- 314124-01 NWT STEPPER MOTOR ASSEMBLY
1-Stepper Motor w/Harness
2-Stepper Pulley
- ⑤

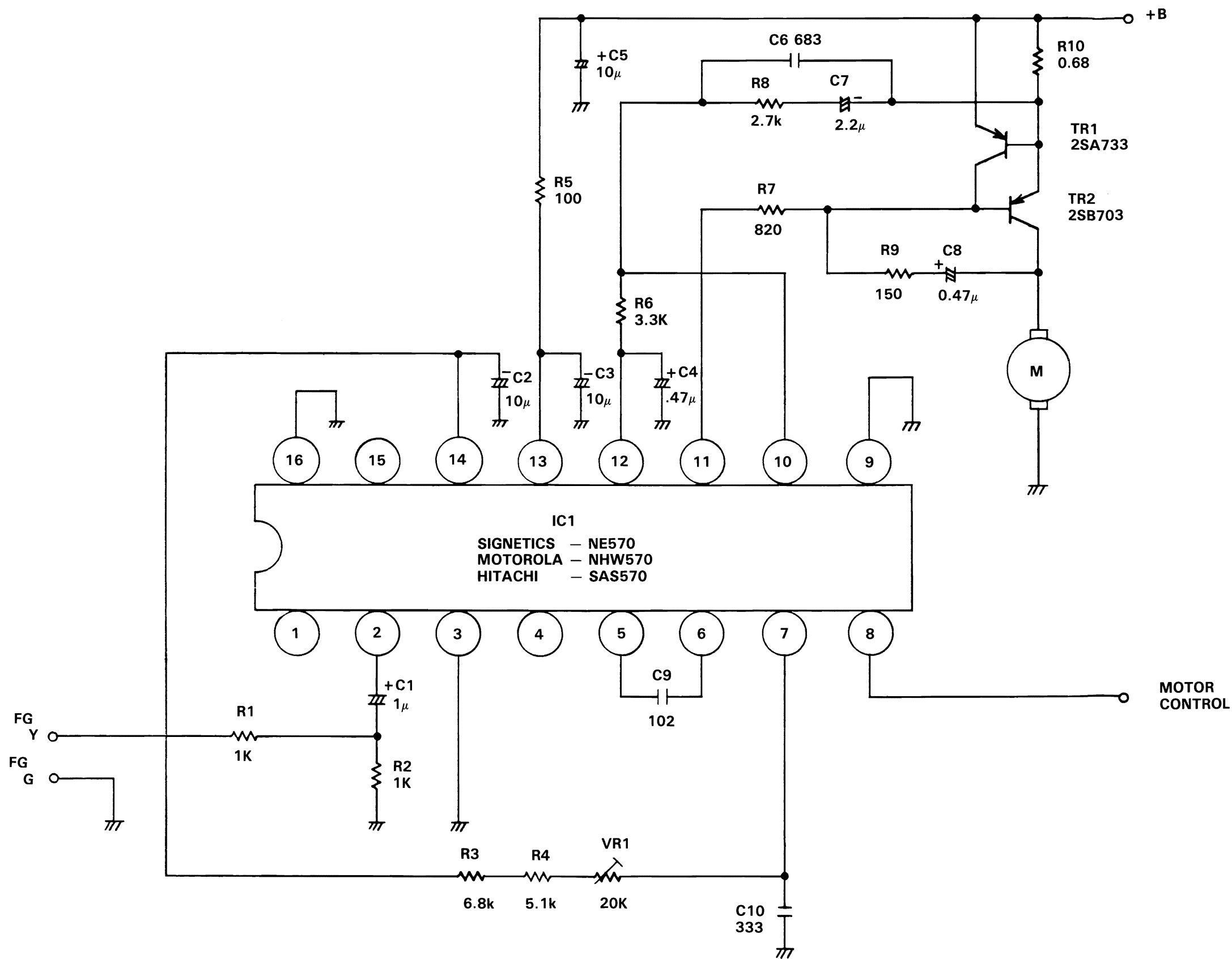
314125-01 NWT D.C. MOTOR
- ⑥

314126-01 NWT MOTOR CONTROL PCB ASSEMBLY
1-Motor Control PCB
2-Harness Assy
- ⑦

314127-01 NWT HOUSING SPINDLE ASSEMBLY
1-Housing Base
2-Spindle Assy
3-L/R Guide Shafts
4-Brass Pulley
- 314128-01 NWT DRIVE BELT
- 314129-01 NWT HARDWARE
1-Assorted Screws
2-Zero Stop Tab
3-Tension Spring
- 314174-01 UNIV Replacement Load Pad



NEWTRONICS MOTOR CONTROL
SCHEMATIC





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